PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver Rev. 1.2 — 13 November 2025 Product

Product data sheet

Document information

Information	Content
Keywords	PCA9958, data sheet, SPI-compatible, 24-channel constant current, LED driver
	PCA9958 is a daisy-chain SPI-compatible 4-wire serial bus controlled 24-channel constant current LED driver optimized for dimming and blinking 63 mA Red/Green/Blue/Amber (RGBA) LEDs.



24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

1 General description

PCA9958 is a daisy-chain SPI-compatible 4-wire serial bus controlled 24-channel constant current LED driver optimized for dimming and blinking 63 mA Red/Green/Blue/Amber (RGBA) LEDs.

Each LED output has its own 8-bit resolution (256 steps) fixed frequency individual PWM controller that operates at 31.25 kHz with a duty cycle that is adjustable from 0 % to 100 % to allow the LED to be set to a specific brightness value. An additional 8-bit resolution (256 steps) group PWM controller has both a fixed frequency of 122 Hz and an adjustable frequency between 15 Hz to once every 16.8 seconds with a duty cycle that is adjustable from 0 % to 99.6 % that is used to either dim or blink all LEDs with the same value.

Each LED output can be off or on (no PWM control), set at its individual PWM controller value or at both individual and group PWM controller values. PCA9958 operates with a supply voltage range of 2.7 V to 5.5 V. The constant current sink LED outputs allow up to 5 V for the LED supply. The output peak current is adjustable with an 8-bit linear DAC from 250 μ A to 63.75 mA with REXT = 1 k Ω .

Gradation control for all current sources is achieved via the 4-wire serial bus interface and allows the user to ramp current automatically without MCU intervention. 8-bit DACs are available to adjust brightness levels for each LED current source. There are six selectable gradation control groups. Each group has four independent registers to control ramp-up and ramp-down rate, step time, hold ON/OFF time, and final hold ON output current. Two gradation operation modes are available for each group: single shot mode (output pattern once) and continuous mode (output pattern repeat). Each channel can be set to either gradation mode or normal mode and assigned to any one of these six gradation control groups.

This device has built-in open, short load and overtemperature detection circuitry. The error information from the corresponding register can be read via the 4-wire serial bus. Also, a thermal shutdown feature protects the device when internal junction temperature exceeds the limit allowed for the process.

PCA9958 device is designed to use 4-wire read/write serial bus with higher data clock frequency (up to 10 MHz).

The active LOW output enable input pin (\overline{OE}) blinks all the LED outputs and can be used to externally PWM the outputs, which is useful when multiple devices must be dimmed or blinked together without using software control.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

2 Features and benefits

- 24 LED drivers. Each output programmable at:
 - Off
 - On
 - 8-bit programmable LED brightness
 - 8-bit programmable group dimming/blinking mixed with individual LED brightness
 - Programmable LED output delay to reduce EMI and surge currents
- · Gradation control for all channels
 - Each channel can be assigned to one of six gradation control groups
 - Programmable gradation time and rate for ramp-up and/or ramp-down operations
 - Programmable step time (6-bit) from 0.5 ms (minimum) to 512 ms (maximum)
 - Programmable hold-on time after ramp-up and hold-off time after ramp-down (3-bit) from 0 s to 6 s
 - Programmable final ramp-up and hold-on current
 - Programmable brightness current output adjustment, either linear or exponential curve
- 24 constant current output channels can sink up to 63 mA, and tolerate up to 5.5 V when OFF
- Output current adjusted through an external resistor (REXT input)
- Output current accuracy
 - ± 7.5 % absolute accuracy with 60 mA output current
 - ± 9 % absolute accuracy with 30 mA output current
 - Maximum ±5 % channel to channel variation
 - Maximum ±7 % device-to-device variation
- Open/short load/overtemperature detection mode to detect individual LED errors
- · 4-wire serial bus interface with 10 MHz data clock rate
- 256-step (8-bit) linear programmable brightness per LED output varying from fully off (default) to maximum brightness fully ON using a 31.25 kHz PWM signal
- 256-step group brightness control allows general dimming (using a 122 Hz PWM signal) from fully off to maximum brightness (default)
- 256-step group blinking with frequency programmable from 15 Hz to 16.8 s, duty cycle from 0 % to 99.6 %
- Active LOW Output Enable (OE) input pin allows for hardware blinking and dimming of the LEDs
- · 8 MHz internal oscillator requiring no external components
- · Internal power-on reset
- No glitch on LEDn outputs on power up
- · Low standby current
- Operating power supply voltage (V_{DD}) range of 2.7 V to 5.5 V
- 5.5 V tolerant inputs on non-LED pins
- -40 °C to +85 °C operation for PCA9958HN; -40 °C to +125 °C operation for PCA9958HN/Q900
- Latch-up performance exceeds 100 mA per JESD 78, Class II
- ESD protection exceeds per JESD22
 - 2 kV Human-Body Model ((JS-001-2023) Class 2)
 - 750 V Charged-Device Model ((JS-002-2022) Class C2b)
- Available in HVQFN40 wettable flanks package
- PCA9958HN/Q900 for automotive (AEC-Q100 compliant)

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

3 Applications

- RGB or RGBA LED drivers
- LED status information
- LED displays
- · LCD backlights
- Keypad backlights for cellular phones or handheld devices
- Fade-in and fade-out for breath light control

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

4 Ordering information

Table 1 describes the ordering information for PCA9958.

Table 1. Ordering information

Type number	Topside mark	Package	Package							
		Name	Description	Version						
PCA9958HN	P9958	HVQFN40	Plastic thermal enhanced very thin quad flat wettable flanks package; no leads; 40 terminals, 0.5 mm pitch, 6 mm x 6 mm x 0.85 mm body	SOT618-21(D)						
PCA9958HN/Q900	P9958Q	HVQFN40	Plastic thermal enhanced very thin quad flat wettable flanks package; no leads; 40 terminals, 0.5 mm pitch, 6 mm x 6 mm x 0.85 mm body	SOT618-21(D)						

4.1 Ordering options

Table 2 describes the ordering options for PCA9958.

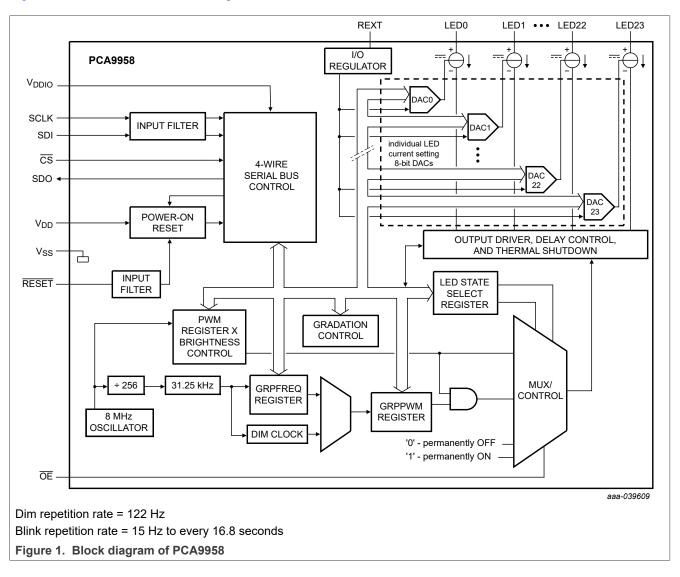
Table 2. Ordering options

Type number	Orderable part number	Package	3	Minimum order quantity	Temperature
PCA9958HN	PCA9958HNY	HVQFN40	Reel 13" Q1 DP	4000	T _{amb} = -40 °C to +85 °C
PCA9958HN/Q900	PCA9958HN/Q900Y	HVQFN40	Reel 13" Q1 DP	4000	T _{amb} = -40 °C to +125 °C

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

5 Block diagram

Figure 1 shows the labeled block diagram of PCA9958.



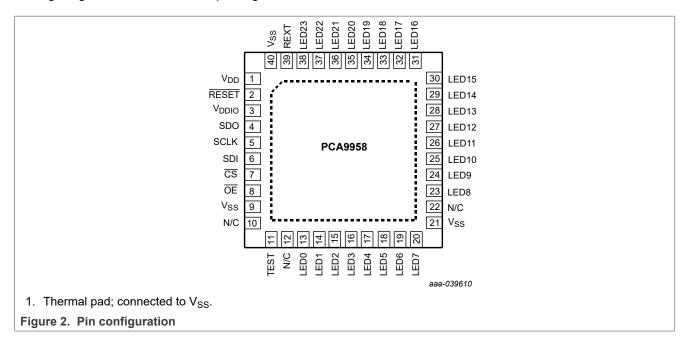
24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

6 Pinning information

This section provides the pin configuration and description for PCA9958.

6.1 Pinning

The figure given below shows the pinning for PCA9958.



6.2 Pin description

Table 3 provides detailed description of various pins on PCA9958.

Table 3. Pin description

Symbol	Pin	Туре	Description
REXT	39	I	Current set resistor input; resistor to ground
SDO	4	0	Serial data output
CS	7	I	Active LOW chip select
ŌĒ	8	I	Active LOW output enable for LEDs
LED0	13	0	LED driver 0
LED1	14	0	LED driver 1
LED2	15	0	LED driver 2
LED3	16	0	LED driver 3
LED4	17	0	LED driver 4
LED5	18	0	LED driver 5
LED6	19	0	LED driver 6
LED7	20	0	LED driver 7
LED8	23	0	LED driver 8

PCA9958

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Table 3. Pin description...continued

Symbol	Pin	Туре	Description
LED9	24	0	LED driver 9
LED10	25	0	LED driver 10
LED11	26	0	LED driver 11
LED12	27	0	LED driver 12
LED13	28	0	LED driver 13
LED14	29	0	LED driver 14
LED15	30	0	LED driver 15
LED16	31	0	LED driver 16
LED17	32	0	LED driver 17
LED18	33	0	LED driver 18
LED19	34	0	LED driver 19
LED20	35	0	LED driver 20
LED21	36	0	LED driver 21
LED22	37	0	LED driver 22
LED23	38	0	LED driver 23
RESET	2	I	Active LOW reset input with external 10 $k\Omega$ pullup resistor
SCLK	5	1	Serial clock line
SDI	6	I	Serial data input
V _{SS}	9, 21, 40 ^[1]	Ground	Supply ground
V _{DDIO}	3	Power supply	Supply rail of SPI interface
V _{DD}	1	Power supply	Supply voltage
N/C	10, 12, 22	N/A	No connection
TEST	11	Factory test	Internal pull down - connect to GND or leave floating

^[1] Package supply ground is connected to both V_{SS} pins and an exposed center pad. V_{SS} pins must be connected to the supply ground for proper device operation. For enhanced thermal, electrical, and board level performance, the exposed pad must be soldered to the board using a corresponding thermal pad on the board. For proper heat conduction through the board, thermal vias must be incorporated in the printed-circuit board in the thermal pad region.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

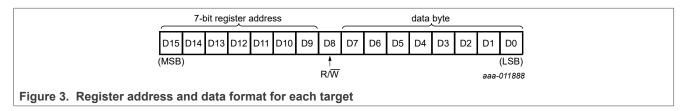
7 Functional description

Refer to Figure 1.

7.1 Register address and data

Following a chip select (\overline{CS}) asserted condition (from HIGH to LOW), the data transfers are $(16 \times n)$ bits wide (where 'n' is the number of targets in the chain) with MSB transferred first. The first 7 bits are the address of the register to be accessed. The eighth bit indicates the types of access - read (= 1) or write (= 0). The second group of 8 bits consists of data as shown in Figure 3.

For more details, see Section 8.



7.2 Register definitions

Table 4 describes the register definitions and related summary for PCA9958.

Table 4. Register summary - default values

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
00h	0	0	0	0	0	0	0	0	MODE1	Read/ write	Mode register 1
01h	0	0	0	0	0	0	0	1	MODE2	Read/ write	Mode register 2
02h	0	0	0	0	0	0	0	0	EFLAG0	Read only	Output error flag 0
03h	0	0	0	0	0	0	0	0	EFLAG1	Read only	Output error flag 1
04h	0	0	0	0	0	0	0	0	EFLAG2	Read only	Output error flag 2
05h	0	0	0	0	0	0	0	0	EFLAG3	Read only	Output error flag 3
06h	0	0	0	0	0	0	0	0	EFLAG4	Read only	Output error flag 4
07h	0	0	0	0	0	0	0	0	EFLAG5	Read only	Output error flag 5
08h	1	0	1	0	1	0	1	0	LEDOUT0	Read/ write	LED output state 0
09h	1	0	1	0	1	0	1	0	LEDOUT1	Read/ write	LED output state 1
0Ah	1	0	1	0	1	0	1	0	LEDOUT2	Read/ write	LED output state 2
0Bh	1	0	1	0	1	0	1	0	LEDOUT3	Read/ write	LED output state 3
0Ch	1	0	1	0	1	0	1	0	LEDOUT4	Read/ write	LED output state 4

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
0Dh	1	0	1	0	1	0	1	0	LEDOUT5	Read/ write	LED output state 5
0Eh	1	1	1	1	1	1	1	1	GRPPWM	Read/ write	Group duty cycle control
0Fh	0	0	0	0	0	0	0	0	GRPFREQ	Read/ write	Group frequency
10h	0	0	0	0	0	0	0	0	PWM0	Read/ write	Brightness control LED0
11h	0	0	0	0	0	0	0	0	PWM1	Read/ write	Brightness control LED1
12h	0	0	0	0	0	0	0	0	PWM2	Read/ write	Brightness control LED2
13h	0	0	0	0	0	0	0	0	PWM3	Read/ write	Brightness control LED3
14h	0	0	0	0	0	0	0	0	PWM4	Read/ write	Brightness control LED4
15h	0	0	0	0	0	0	0	0	PWM5	Read/ write	Brightness control LED5
16h	0	0	0	0	0	0	0	0	PWM6	Read/ write	Brightness control LED6
17h	0	0	0	0	0	0	0	0	PWM7	Read/ write	Brightness control LED7
18h	0	0	0	0	0	0	0	0	PWM8	Read/ write	Brightness control LED8
19h	0	0	0	0	0	0	0	0	PWM9	Read/ write	Brightness control LED9
1Ah	0	0	0	0	0	0	0	0	PWM10	Read/ write	Brightness control LED10
1Bh	0	0	0	0	0	0	0	0	PWM11	Read/ write	Brightness control LED11
1Ch	0	0	0	0	0	0	0	0	PWM12	Read/ write	Brightness control LED12
1Dh	0	0	0	0	0	0	0	0	PWM13	Read/ write	Brightness control LED13
1Eh	0	0	0	0	0	0	0	0	PWM14	Read/ write	Brightness control LED14
1Fh	0	0	0	0	0	0	0	0	PWM15	Read/ write	Brightness control LED15
20h	0	0	0	0	0	0	0	0	PWM16	Read/ write	Brightness control LED16
21h	0	0	0	0	0	0	0	0	PWM17	Read/ write	Brightness control LED17

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
22h	0	0	0	0	0	0	0	0	PWM18	Read/ write	Brightness control LED18
23h	0	0	0	0	0	0	0	0	PWM19	Read/ write	Brightness control LED19
24h	0	0	0	0	0	0	0	0	PWM20	Read/ write	Brightness control LED20
25h	0	0	0	0	0	0	0	0	PWM21	Read/ write	Brightness control LED21
26h	0	0	0	0	0	0	0	0	PWM22	Read/ write	Brightness control LED22
27h	0	0	0	0	0	0	0	0	PWM23	Read/ write	Brightness control LED23
28h	0	0	0	0	0	0	0	0	IREF0	Read/ write	Output gain control register 0
29h	0	0	0	0	0	0	0	0	IREF1	Read/ write	Output gain control register 1
2Ah	0	0	0	0	0	0	0	0	IREF2	Read/ write	Output gain control register 2
2Bh	0	0	0	0	0	0	0	0	IREF3	Read/ write	Output gain control register 3
2Ch	0	0	0	0	0	0	0	0	IREF4	Read/ write	Output gain control register 4
2Dh	0	0	0	0	0	0	0	0	IREF5	Read/ write	Output gain control register 5
2Eh	0	0	0	0	0	0	0	0	IREF6	Read/ write	Output gain control register 6
2Fh	0	0	0	0	0	0	0	0	IREF7	Read/ write	Output gain control register 7
30h	0	0	0	0	0	0	0	0	IREF8	Read/ write	Output gain control register 8
31h	0	0	0	0	0	0	0	0	IREF9	Read/ write	Output gain control register 9
32h	0	0	0	0	0	0	0	0	IREF10	Read/ write	Output gain control register 10
33h	0	0	0	0	0	0	0	0	IREF11	Read/ write	Output gain control register 11
34h	0	0	0	0	0	0	0	0	IREF12	Read/ write	Output gain control register 12
35h	0	0	0	0	0	0	0	0	IREF13	Read/ write	Output gain control register 13
36h	0	0	0	0	0	0	0	0	IREF14	Read/ write	Output gain control register 14

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
37h	0	0	0	0	0	0	0	0	IREF15	Read/ write	Output gain control register 15
38h	0	0	0	0	0	0	0	0	IREF16	Read/ write	Output gain control register 16
39h	0	0	0	0	0	0	0	0	IREF17	Read/ write	Output gain control register 17
3Ah	0	0	0	0	0	0	0	0	IREF18	Read/ write	Output gain control register 18
3Bh	0	0	0	0	0	0	0	0	IREF19	Read/ write	Output gain control register 19
3Ch	0	0	0	0	0	0	0	0	IREF20	Read/ write	Output gain control register 20
3Dh	0	0	0	0	0	0	0	0	IREF21	Read/ write	Output gain control register 21
3Eh	0	0	0	0	0	0	0	0	IREF22	Read/ write	Output gain control register 22
3Fh	0	0	0	0	0	0	0	0	IREF23	Read/ write	Output gain control register 23
40h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP0	Read/ write	Ramp enable and rate control for group 0
41h	0	0	0	0	0	0	0	0	STEP_TIME_GRP0	Read/ write	Step time control for group 0
42h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP0	Read/ write	Hold ON/OFF time control for group 0
43h	0	0	0	0	0	0	0	0	IREF_GRP0	Read/ write	Output gain control for group 0
44h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP1	Read/ write	Ramp enable and rate control for group 1
45h	0	0	0	0	0	0	0	0	STEP_TIME_GRP1	Read/ write	Step time control for group 1
46h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP1	Read/ write	Hold ON/OFF time control for group 1
47h	0	0	0	0	0	0	0	0	IREF_GRP1	Read/ write	Output gain control for group 1
48h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP2	Read/ write	Ramp enable and rate control for group 2
49h	0	0	0	0	0	0	0	0	STEP_TIME_GRP2	Read/ write	Step time control for group 2
4Ah	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP2	Read/ write	Hold ON/OFF time control for group 2
4Bh	0	0	0	0	0	0	0	0	IREF_GRP2	Read/ write	Output gain control for group 2

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
4Ch	0	0	0	0	0	0	0	0	RAMP_RATE_GRP3	Read/ write	Ramp enable and rate control for group 3
4Dh	0	0	0	0	0	0	0	0	STEP_TIME_GRP3	Read/ write	Step time control for group 3
4Eh	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP3	Read/ write	Hold ON/OFF time control for group 3
1Fh	0	0	0	0	0	0	0	0	IREF_GRP3	Read/ write	Output gain control for group 3
50h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP4	Read/ write	Ramp enable and rate control for group 4
51h	0	0	0	0	0	0	0	0	STEP_TIME_GRP4	Read/ write	Step time control for group 4
52h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP4	Read/ write	Hold ON/OFF time control for group 4
53h	0	0	0	0	0	0	0	0	IREF_GRP4	Read/ write	Output gain control for group 4
54h	0	0	0	0	0	0	0	0	RAMP_RATE_GRP5	Read/ write	Ramp enable and rate control for group 5
55h	0	0	0	0	0	0	0	0	STEP_TIME_GRP5	Read/ write	Step time control for group 5
56h	0	0	0	0	0	0	0	0	HOLD_CNTL_GRP5	Read/ write	Hold ON/OFF time control for group 5
57h	0	0	0	0	0	0	0	0	IREF_GRP5	Read/ write	Output gain control for group 5
58h	0	0	0	0	0	0	0	0	GRAD_MODE_SEL0	Read/ write	Gradation mode select register for channel 7 to channel 0
59h	0	0	0	0	0	0	0	0	GRAD_MODE_SEL1	Read/ write	Gradation mode select register for channel 15 to channel 8
5Ah	0	0	0	0	0	0	0	0	GRAD_MODE_SEL2	Read/ write	Gradation mode select register for channel 23 to channel 16
5Bh	0	0	0	0	0	0	0	0	GRAD_GRP_SEL0	Read/ write	Gradation group select for channel 1 to channel 0
5Ch	0	0	0	0	0	0	0	0	GRAD_GRP_SEL1	Read/ write	Gradation group select for channel 3 to channel 2
5Dh	0	0	0	1	0	0	0	1	GRAD_GRP_SEL2	Read/ write	Gradation group select for channel 5 to channel 4
5Eh	0	0	0	1	0	0	0	1	GRAD_GRP_SEL3	Read/ write	Gradation group select for channel 7 to channel 6
5Fh	0	0	1	0	0	0	1	0	GRAD_GRP_SEL4	Read/ write	Gradation group select for channel 9 to channel 8
60h	0	0	1	0	0	0	1	0	GRAD_GRP_SEL5	Read/ write	Gradation group select for channel 11 to channel 10

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 4. Register summary - default values...continued

Register # (hex)	D7	D6	D5	D4	D3	D2	D1	D0	Name	Туре	Function
61h	0	0	1	1	0	0	1	1	GRAD_GRP_SEL6	Read/ write	Gradation group select for channel 13 to channel 12
62h	0	0	1	1	0	0	1	1	GRAD_GRP_SEL7	Read/ write	Gradation group select for channel 15 to channel 14
63h	0	1	0	0	0	1	0	0	GRAD_GRP_SEL8	Read/ write	Gradation group select for channel 17 to channel 16
64h	0	1	0	0	0	1	0	0	GRAD_GRP_SEL9	Read/ write	Gradation group select for channel 19 to channel 18
65h	0	1	0	1	0	1	0	1	GRAD_GRP_SEL10	Read/ write	Gradation group select for channel 21 to channel 20
66h	0	1	0	1	0	1	0	1	GRAD_GRP_SEL11	Read/ write	Gradation group select for channel 23 to channel 22
67h	0	0	0	0	0	0	0	0	GRAD_CNTL0	Read/ write	Gradation control register for group 3 to group 0
68h	0	0	0	0	0	0	0	0	GRAD_CNTL1	Read/ write	Gradation control register for group 5 to group 4
69h	0	0	0	0	1	0	0	0	OFFSET	Read/ write	Offset/delay on LEDn outputs
6Ah	0	0	0	0	0	0	0	0	PWMALL	Write only	Brightness control for all LEDn
6Bh	0	0	0	0	0	0	0	0	IREFALL	Write only	Output gain control for all registers IREF0 to IREF23
6Ch											
to	:	:	:	:	:	:	:	:	Reserved ^[1]	Read only	Not used
7Fh											

 $[\]label{eq:continuous} \textbf{[1]} \qquad \text{Reserved registers must not be written to - the default is 0.}$

7.2.1 MODE1 — Mode register 1

Table 5. MODE1 - Mode register 1 (address 00h) bit description Legend: * default value.

Bit	Symbol	Access	Value	Description
7	-	Read only	0*	Reserved
6	-	R/W	0*	Reserved
5	-	R/W	0*	Reserved
4	SLEEP	R/W	0*	Normal mode ^[1]
			1	Low-power mode. Oscillator off ^{[2][3]} .
3	-	R/W	0*	Reserved
2	-	R/W	0*	Reserved
1	-	R/W	0*	Reserved
0	-	R/W	0*	Reserved

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

- [1] It takes 500 µs max, for the oscillator to be up and running once the SLEEP bit has been set to logic 0. Timings on LEDn outputs are not guaranteed if PWMx, GRPPWM, or GRPFREQ registers are accessed within the 500 µs window.
- [2] No blinking, dimming, or gradation control is possible when the oscillator is off.
- The device must be reset if the LED driver output state is set to LDRx=11 after the device is set back to Normal mode.

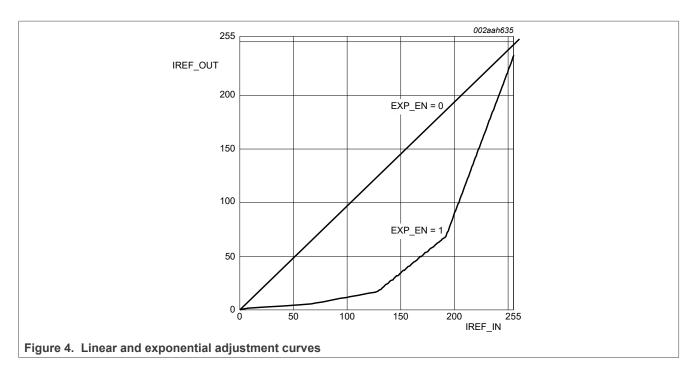
7.2.2 MODE2 — Mode register 2

Table 6. MODE2 - Mode register 2 (address 01h) bit description Legend: * default value.

Bit	Symbol	Access	Value	Description
7	OVERTEMP	Read only	0*	O.K.
			1	Overtemperature condition
6	ERROR	Read only	0*	No error at LED outputs
			1	Any open or short-circuit detected in error flag registers (EFLAGn)
5	DMBLNK	R/W	0*	Group control = dimming
			1	Group control = blinking
4	CLRERR	Write only	0*	Self clear after write '1'
			1	Write '1' to clear all error status bits in the EFLAGn register and ERROR (bit 6). The EFLAGn and ERROR bit sets to '1' if an open or short-circuit is detected again.
3	AUTO_ SWITCHOFF_DIS	R/W	0*	Disable the channel for which an open or short error is detected and enable it again when write 1 to CLRERR, clears all error status bits in EFLAGn registers and ERROR bit.
			1	The channel does not turn off when open/short detected
2	EXP_EN	R/W	0*	Linear adjustment for gradation control
			1	Exponential adjustment for gradation control
1	-	Read only	0*	Reserved
0	-	Read only	1*	Reserved

Brightness adjustment for gradation control is either linear or exponential by setting the EXP_EN bit as shown in <u>Figure 4</u>. When EXP_EN = 0, a linear adjustment scale is used. When EXP_EN = 1, the exponential scale is used.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



7.2.3 LEDOUT0 to LEDOUT5, LED driver output state

Table 7. LEDOUT0 to LEDOUT5 - LED driver output state registers (address 08h to 0Dh) bit description Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
08h	LEDOUT0	7:6	LDR3	R/W	10*	LED3 output state control
		5:4	LDR2	R/W	10*	LED2 output state control
		3:2	LDR1	R/W	10*	LED1 output state control
		1:0	LDR0	R/W	10*	LED0 output state control
09h	LEDOUT1	7:6	LDR7	R/W	10*	LED7 output state control
		5:4	LDR6	R/W	10*	LED6 output state control
		3:2	LDR5	R/W	10*	LED5 output state control
		1:0	LDR4	R/W	10*	LED4 output state control
0Ah	LEDOUT2	7:6	LDR11	R/W	10*	LED11 output state control
		5:4	LDR10	R/W	10*	LED10 output state control
		3:2	LDR9	R/W	10*	LED9 output state control
		1:0	LDR8	R/W	10*	LED8 output state control
0Bh	LEDOUT3	7:6	LDR15	R/W	10*	LED15 output state control
		5:4	LDR14	R/W	10*	LED14 output state control
		3:2	LDR13	R/W	10*	LED13 output state control
		1:0	LDR12	R/W	10*	LED12 output state control
0Ch	LEDOUT4	7:6	LDR19	R/W	10*	LED19 output state control
		5:4	LDR18	R/W	10*	LED18 output state control

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 7. LEDOUT0 to LEDOUT5 - LED driver output state registers (address 08h to 0Dh) bit description...continued Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
		3:2	LDR17	R/W	10*	LED17 output state control
		1:0	LDR16	R/W	10*	LED16 output state control
0Dh	LEDOUT5	7:6	LDR23	R/W	10*	LED23 output state control
		5:4	LDR22	R/W	10*	LED22 output state control
		3:2	LDR21	R/W	10*	LED21 output state control
		1:0	LDR20	R/W	10*	LED20 output state control

LDRx = 00: LED driver x is off (x = 0 to 23).

LDRx = 01: LED driver x is fully on (individual brightness and group dimming/blinking not controlled). The OE pin can be used as an external dimming/blinking control in this state.

LDRx = 10: LED driver x individual brightness can be controlled through its PWMx register (default power up state) or PWMALL register for all LEDn outputs.

LDRx = 11: LED driver x individual brightness and group dimming/blinking can be controlled through its PWMx register and the GRPPWM registers.

Remark: Setting the device in low power mode while being on group dimming/blinking mode (LDRx = 11) can cause the LED output state to be in an unknown state after the device is set back to normal mode. The device must be reset and all register values reprogrammed.

7.2.4 GRPPWM, group duty cycle control

Table 8. GRPPWM - Group brightness control register (address 0Eh) bit description Legend: * default value

Address	Register	Bit	Symbol	Access	Value	Description
0Eh	GRPPWM	7:0	GDC[7:0]	R/W	1111 1111*	GRPPWM register

When DMBLNK bit (MODE2 register) is programmed with logic 0, a 122 Hz fixed frequency signal is superimposed with the 31.25 kHz individual brightness control signal. GRPPWM is then used as a global brightness control, allowing the LED outputs to be dimmed with the same value. The value in GRPFREQ is then a 'Don't care'.

General brightness for the 24 outputs is controlled through 255 linear steps from 00h (0 % duty cycle = LED output off) to FFh (99.6 % duty cycle = maximum brightness). Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers).

When DMBLNK bit is programmed with logic 1, GRPPWM and GRPFREQ registers define a global blinking pattern, where GRPFREQ contains the blinking period (from 67 ms to 16.8 s) and GRPPWM the duty cycle (ON/OFF ratio in %).

$$dutycycle = \frac{GDC [7:0]}{256} \tag{1}$$

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

7.2.5 GRPFREQ, group frequency

Table 9. GRPFREQ - Group frequency register (address 0Fh) bit description Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
0Fh	GRPFREQ	7:0	GFRQ[7:0]	R/W	0000 0000*	GRPFREQ register

GRPFREQ is used to program the global blinking period when the DMBLNK bit (MODE2 register) is equal to 1. Value in this register is a 'Don't care' when DMBLNK = 0. Applicable to LED outputs programmed with LDRx = 11 (LEDOUT0 to LEDOUT3 registers).

Blinking period is controlled through 256 linear steps from 00h (67 ms, frequency 15 Hz) to FFh (16.8 s).

$$globalblinkingperiod = \frac{GFRQ[7:0]+1}{15.26} (s)$$
 (2)

7.2.6 PWM0 to PWM23, individual brightness control

Table 10. PWM0 to PWM23 - PWM registers 0 to 23 (address 10h to 27h) bit description Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
10h	PWM0	7:0	IDC0[7:0]	R/W	0000 0000*	PWM0 Individual Duty Cycle
11h	PWM1	7:0	IDC1[7:0]	R/W	0000 0000*	PWM1 Individual Duty Cycle
12h	PWM2	7:0	IDC2[7:0]	R/W	0000 0000*	PWM2 Individual Duty Cycle
13h	PWM3	7:0	IDC3[7:0]	R/W	0000 0000*	PWM3 Individual Duty Cycle
14h	PWM4	7:0	IDC4[7:0]	R/W	0000 0000*	PWM4 Individual Duty Cycle
15h	PWM5	7:0	IDC5[7:0]	R/W	0000 0000*	PWM5 Individual Duty Cycle
16h	PWM6	7:0	IDC6[7:0]	R/W	0000 0000*	PWM6 Individual Duty Cycle
17h	PWM7	7:0	IDC7[7:0]	R/W	0000 0000*	PWM7 Individual Duty Cycle
18h	PWM8	7:0	IDC8[7:0]	R/W	0000 0000*	PWM8 Individual Duty Cycle
19h	PWM9	7:0	IDC9[7:0]	R/W	0000 0000*	PWM9 Individual Duty Cycle
1Ah	PWM10	7:0	IDC10[7:0]	R/W	0000 0000*	PWM10 Individual Duty Cycle
1Bh	PWM11	7:0	IDC11[7:0]	R/W	0000 0000*	PWM11 Individual Duty Cycle
1Ch	PWM12	7:0	IDC12[7:0]	R/W	0000 0000*	PWM12 Individual Duty Cycle
1Dh	PWM13	7:0	IDC13[7:0]	R/W	0000 0000*	PWM13 Individual Duty Cycle
1Eh	PWM14	7:0	IDC14[7:0]	R/W	0000 0000*	PWM14 Individual Duty Cycle
1Fh	PWM15	7:0	IDC15[7:0]	R/W	0000 0000*	PWM15 Individual Duty Cycle
20h	PWM16	7:0	IDC8[7:0]	R/W	0000 0000*	PWM16 Individual Duty Cycle
21h	PWM17	7:0	IDC9[7:0]	R/W	0000 0000*	PWM17 Individual Duty Cycle
22h	PWM18	7:0	IDC10[7:0]	R/W	0000 0000*	PWM18 Individual Duty Cycle
23h	PWM19	7:0	IDC11[7:0]	R/W	0000 0000*	PWM19 Individual Duty Cycle
24h	PWM20	7:0	IDC12[7:0]	R/W	0000 0000*	PWM20 Individual Duty Cycle

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 10. PWM0 to PWM23 - PWM registers 0 to 23 (address 10h to 27h) bit description...continued Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
25h	PWM21	7:0	IDC13[7:0]	R/W	0000 0000*	PWM21 Individual Duty Cycle
26h	PWM22	7:0	IDC14[7:0]	R/W	0000 0000*	PWM22 Individual Duty Cycle
27h	PWM23	7:0	IDC15[7:0]	R/W	0000 0000*	PWM23 Individual Duty Cycle

A 31.25 kHz fixed frequency signal is used for each output. Duty cycle is controlled through 255 linear steps from 00h (0 % duty cycle = LED output off) to FEh (99.2 % duty cycle = LED output at maximum brightness) and FFh (100 % duty cycle = LED output completed ON). Applicable to LED outputs programmed with LDRx = 10 or 11 (LEDOUT0 to LEDOUT3 registers).

$$dutycycle = \frac{IDCx[7:0]}{256} \tag{3}$$

Remark: The first lower end 8 steps of PWM and the last (higher end) steps of PWM do not have effective brightness control of LEDs due to edge rate control of LED output pins.

7.2.7 IREF0 to IREF23, LED output current value registers

These registers reflect the gain settings for output current for LED0 to LED23.

Table 11. IREF0 to IREF23 - LED output gain control registers (address 28h to 3Fh) bit description Legend: * default value.

Address	Register	Bit	Access	Value	Description
28h	IREF0	7:0	R/W	00h*	LED0 output current setting
29h	IREF1	7:0	R/W	00h*	LED1 output current setting
2Ah	IREF2	7:0	R/W	00h*	LED2 output current setting
2Bh	IREF3	7:0	R/W	00h*	LED3 output current setting
2Ch	IREF4	7:0	R/W	00h*	LED4 output current setting
2Dh	IREF5	7:0	R/W	00h*	LED5 output current setting
2Eh	IREF6	7:0	R/W	00h*	LED6 output current setting
2Fh	IREF7	7:0	R/W	00h*	LED7 output current setting
30h	IREF8	7:0	R/W	00h*	LED8 output current setting
31h	IREF9	7:0	R/W	00h*	LED9 output current setting
32h	IREF10	7:0	R/W	00h*	LED10 output current setting
33h	IREF11	7:0	R/W	00h*	LED11 output current setting
34h	IREF12	7:0	R/W	00h*	LED12 output current setting
35h	IREF13	7:0	R/W	00h*	LED13 output current setting
36h	IREF14	7:0	R/W	00h*	LED14 output current setting
37h	IREF15	7:0	R/W	00h*	LED15 output current setting
38h	IREF16	7:0	R/W	00h*	LED16 output current setting
39h	IREF17	7:0	R/W	00h*	LED17 output current setting

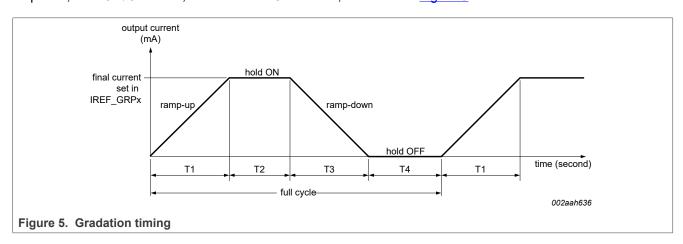
24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 11. IREF0 to IREF23 - LED output gain control registers (address 28h to 3Fh) bit description...continued Legend: * default value.

Address	Register	Bit	Access	Value	Description
3Ah	IREF18	7:0	R/W	00h*	LED18 output current setting
3Bh	IREF19	7:0	R/W	00h*	LED19 output current setting
3Ch	IREF20	7:0	R/W	00h*	LED20 output current setting
3Dh	IREF21	7:0	R/W	00h*	LED21 output current setting
3Eh	IREF22	7:0	R/W	00h*	LED22 output current setting
3Fh	IREF23	7:0	R/W	00h*	LED23 output current setting

7.2.8 Gradation control

Gradation control is designed to use six independent groups of registers to program the full cycle of the gradation timing to implement on each selected channel. Each group has four registers to define the ramp rate, step time, hold ON/OFF time, and final hold ON current, as shown in Figure 5.



- The 'final' and 'hold ON' current is defined in IREF_GRPx register value × (250 μA if REXT = 1 kΩ).
- The ramp rate value and enable/disable ramp operation is defined in the RAMP RATE GRPx register.
- The total number of ramp steps (or level changes) is calculated as 'IREF_GRPx value' ÷ 'ramp rate value in RAMP_RATE_GRPx'. Rounds a number up to the next integer if the total number is not an integer.
- Time for each step is calculated as 'cycle time' × 'multiple factor' bits in the STEP_TIME_GRPx register. The minimum time for one step is 0.5 ms (0.5 ms × 1) and the maximum time is 512 ms (8 ms × 64).
- The ramp-up or ramp-down time (T1 or T3) is calculated as '(total steps + 1)' × 'step time'.
- Hold ON or OFF time (T2 or T4) is defined in the HOLD_CNTL_GRPx register in the range of 0/0.25/0.5/0.75/1/2/4/6 seconds.
- Gradation starts/stops with single shot mode (one full cycle only) or continuous mode (repeat full cycle) is defined in the GRAD_CNTL register for all groups.
- Each channel can be assigned to one of these six groups in the GRAD GRP SELx register.
- Each channel can set either normal mode or gradation mode operation in the GRAD_MODE_SELx register.

To enable the gradation operation, the following steps are required:

- 1. Program all gradation control registers except the gradation start bit in the GRAD_CNTL register.
- 2. Program either LDRx = 01 (LED fully ON mode) only, or LDRx = 10 or 11 (PWM control mode) with individual brightness control PWMx register for duty cycle.
- 3. Program output current value IREFx register to non-zero, which enables LED output.

PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

4. Set the gradation start bit in the GRAD_CNTL register for enabling gradation operation.

7.2.8.1 RAMP_RATE_GRP0 to RAMP_RATE_GRP5, ramp rate control registers

Table 12. RAMP_RATE_GRP[0:3] - Ramp enable and rate control registers (address 40h, 44h, 48h, 4Ch, 50h, 54h) for each group bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description
40h	RAMP_RATE_GRP0	7	R/W	0*	Ramp-up disable
44h	RAMP_RATE_GRP1			1	Ramp-up enable
48h 4Ch	RAMP_RATE_GRP2 RAMP_RATE_GRP3	6	R/W	0*	Ramp-down disable
50h	RAMP_RATE_GRP4			1	Ramp-down enable
54h	RAMP_RATE_GRP5	5:0	R/W	0x00*	The ramp rate value per step is defined from 1 (00h) to 64 (3Fh). [1][2]

- [1] The total number of ramp steps is defined as 'IREF_GRP[7:0]' ÷ 'ramp_rate[5:0]'. (Round up to the next integer if it is not an integer number.)
- Per step current increment or decrement is calculated by the (ramp_rate \times I_{ref}), where the I_{ref} reference current is 250 μ A (REXT = 1 k Ω).

7.2.8.2 STEP_TIME_GRP0 to STEP_TIME_GRP5, step time control registers

Table 13. STEP_TIME_GRP[0:3] - Step time control registers (address 41h, 45h, 49h, 4Dh, 51h, 55h) for each group bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description
41h	STEP_TIME_GRP0	7	Read only	0*	Reserved
45h 49h	STEP_TIME_GRP1 STEP TIME GRP2	6	R/W	0*	Cycle time is set to 0.5 ms.
4911 4Dh	STEP_TIME_GRP2			1	Cycle time is set to 8 ms.
51h	STEP_TIME_GRP4	5:0	R/W	0x00*	Multiple factor per step, the multiple factor is
55h	STEP_TIME_GRP5				defined from 1 (00h) to 64 (3Fh). ^[1]

^[1] Step time = cycle time (0.5 ms or 8 ms) × multiple factor (1 ~ 64). The minimum step time is 0.5 ms and the maximum step time is 512 ms.

7.2.8.3 HOLD CNTL GRP0 to HOLD CNTL GRP5, hold ON and OFF control registers

Table 14. HOLD_CNTL_GRP[0:3] - Hold ON and OFF enable and time control registers (address 42h, 46h, 4Ah, 4Eh, 52h, 56h) for each group bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description
42h	HOLD_CNTL_GRP0	7	R/W	0*	Hold ON disable
46h	HOLD_CNTL_GRP1			1	Hold ON enable
4Ah 4Eh	HOLD_CNTL_GRP2 HOLD_CNTL_GRP3	6	R/W	0*	Hold OFF disable
52h	HOLD_CNTL_GRP4			1	Hold OFF enable
56h	HOLD_CNTL_GRP5	5:3	R/W	000*	Hold ON time select: ^[1]
					000: 0 s
					001: 0.25 s
					010: 0.5 s
					011: 0.75 s

PCA9958

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24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 14. HOLD_CNTL_GRP[0:3] - Hold ON and OFF enable and time control registers (address 42h, 46h, 4Ah, 4Eh, 52h, 56h) for each group bit description...continued

Legend: * default value.

Address	Register	Bit	Access	Value	Description
					100: 1 s
					101: 2 s
					110: 4 s
					111: 6 s
		2:0	R/W	000*	Hold OFF time select: [1]
					000: 0 s
					001: 0.25 s
					010: 0.5 s
					011: 0.75 s
					100: 1 s
					101: 2 s
					110: 4 s
					111: 6 s

^[1] Hold ON or OFF minimum time is 0 s and maximum time is 6 s.

7.2.8.4 IREF_GRP0 to IREF_GRP5, output gain control

Table 15. IREF_GRP[0:3] - Final and hold ON output gain setting registers (address 43h, 47h, 4Bh, 4Fh, 53h, 57h) for each group bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description
43h	IREF_GRP0	7:0	R/W	00h*	Final ramp-up and hold ON output current
47h	IREF_GRP1				gain setting ^[1]
4Bh	IREF_GRP2				
4Fh	IREF_GRP3				
53h	IREF_GRP4				
57h	IREF_GRP5				

^[1] Output current = I_{ref} × IREF_GRPx[7:0], where I_{ref} is reference current. I_{ref} = 250 μ A if REXT = 1 $k\Omega$.

7.2.8.5 GRAD_MODE_SEL0 to GRAD_MODE_SEL2, Gradation mode select registers

Table 16. GRAD_MODE_SEL[0:1] - Gradation mode select register for channel 23 to channel 0 (address 58h, 59h, 5Ah) bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description ^{[1][2]}
58h	GRAD_MODE_SEL0	7:0	R/W	00*	Normal operation mode for channel 7 to channel 0
				FFh	Gradation operation mode for channel 7 to channel 0
59h	GRAD_MODE_SEL1	7:0	R/W	00*	Normal operation mode for channel 15 to channel 8
				FFh	Gradation operation mode for channel 15 to channel 8

PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 16. GRAD_MODE_SEL[0:1] - Gradation mode select register for channel 23 to channel 0 (address 58h, 59h, 5Ah) bit description...continued

Legend: * default value.

Address	Register	Bit	Access	Value	Description ^{[1][2]}
5Ah	GRAD_MODE_SEL2	7:0	R/W	00*	Normal operation mode for channel 23 to channel 16
				FFh	Gradation operation mode for channel 23 to channel 16

Each bit represents one channel that can set either 0 for normal mode (use IREFx to set individual LED output current), or 1 for gradation mode (use

7.2.8.6 GRAD_GRP_SEL0 to GRAD_GRP_SEL11, Gradation group select registers

Table 17. GRAD_GRP_SEL[0:3] - Gradation group select register for channel 23 to channel 0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh, 60h, 61h, 62h, 63h, 64h, 65h, 66h) bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description [1]
5Bh	GRAD_GRP_SEL0	7	R/W	0*	Reserved
		6:4	R/W	000*	Gradation group select for LED1 output
		3	R/W	0*	Reserved
		2:0	R/W	000*	Gradation group select for LED0 output
5Ch	GRAD_GRP_SEL1	7	R/W	0*	Reserved
		6:4	R/W	000*	Gradation group select for LED3 output
		3	R/W	0*	Reserved
		2:0	R/W	000*	Gradation group select for LED2 output
5Dh	GRAD_GRP_SEL2	7	R/W	0*	Reserved
		6:4	R/W	001*	Gradation group select for LED5 output
		3	R/W	0*	Reserved
		2:0	R/W	001*	Gradation group select for LED4 output
5Eh	GRAD_GRP_SEL3	7	R/W	0*	Reserved
		6:4	R/W	001*	Gradation group select for LED7 output
		3	R/W	0*	Reserved
		2:0	R/W	001*	Gradation group select for LED6 output
5Fh	GRAD_GRP_SEL4	7	R/W	0*	Reserved
		6:4	R/W	010*	Gradation group select for LED9 output
		3	R/W	0*	Reserved
		2:0	R/W	010*	Gradation group select for LED8 output
60h	GRAD_GRP_SEL5	7	R/W	0*	Reserved
		6:4	R/W	010*	Gradation group select for LED11 output
		3	R/W	0*	Reserved

IREF_GRPx to set group LEDs output current.).
In gradation mode, it only affects the source of the IREF current level and does not affect the PWMx operation or LEDOUTx register function. It is possible to use the gradation feature, individual PWMx, and group PWM simultaneously.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 17. GRAD_GRP_SEL[0:3] - Gradation group select register for channel 23 to channel 0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh, 60h, 61h, 62h, 63h, 64h, 65h, 66h) bit description...continued Legend: * default value.

Address	Register	Bit	Access	Value	Description ^[1]
		2:0	R/W	010*	Gradation group select for LED10 output
61h	GRAD_GRP_SEL6	7	R/W	0*	Reserved
		6:4	R/W	011*	Gradation group select for LED13 output
		3	R/W	0*	Reserved
		2:0	R/W	011*	Gradation group select for LED12 output
62h	GRAD_GRP_SEL7	7	R/W	0*	Reserved
		6:4	R/W	011*	Gradation group select for LED15 output
		3	R/W	0*	Reserved
		2:0	R/W	011*	Gradation group select for LED14 output
63h	GRAD_GRP_SEL8	7	R/W	0*	Reserved
		6:4	R/W	100*	Gradation group select for LED17 output
		3	R/W	0*	Reserved
		2:0	R/W	100*	Gradation group select for LED16 output
64h	GRAD_GRP_SEL9	7	R/W	0*	Reserved
		6:4	R/W	100*	Gradation group select for LED19 output
		3	R/W	0*	Reserved
		2:0	R/W	100*	Gradation group select for LED18 output
65h	GRAD_GRP_SEL10	7	R/W	0*	Reserved
		6:4	R/W	101*	Gradation group select for LED21 output
		3	R/W	0*	Reserved
		2:0	R/W	101*	Gradation group select for LED20 output
66h	GRAD_GRP_SEL11	7	R/W	0*	Reserved
		6:4	R/W	101*	Gradation group select for LED23 output
		3	R/W	0*	Reserved
		2:0	R/W	101*	Gradation group select for LED22 output

^[1] LED[3:0] outputs default assigned to group 0; LED[7:4] outputs default assigned to group 1; LED[11:8] outputs default assigned to group 2; LED[15:12] outputs default assigned to group 3; LED[19:16] outputs default assigned to group 4; LED[23:20] outputs default assigned to group 5.

7.2.8.7 GRAD_CNTL, Gradation control register

Table 18. GRAD_CNTL[0:1] - Gradation control register for group 5 to group 0 (address 67h, 68h) bit description

Legend: * default value.

Address	Register	Bit	Access	Value	Description
67h	GRAD_CNTL0	7	R/W	0*	Gradation stop or done for group 3 ^[1]
				1	Gradation start for group 3 ^[2]
		6	R/W	0*	Single shot operation for group 3

PCA9958

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24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 18. GRAD_CNTL[0:1] - Gradation control register for group 5 to group 0 (address 67h, 68h) bit description...continued

Legend: * default value.

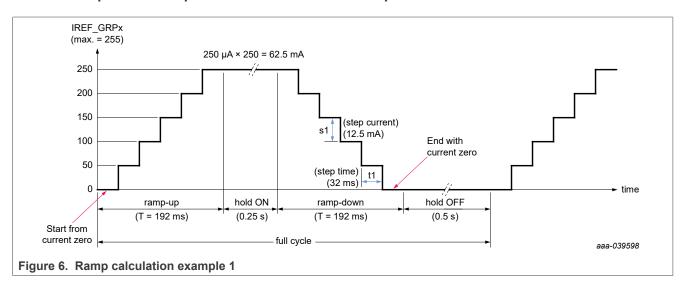
Address	Register	Bit	Access	Value	Description
				1	Continuous operation for group 3
		5	R/W	0*	Gradation stop or done for group 2 [1]
				1	Gradation start for group 2 [2]
		4	R/W	0*	Single shot operation for group 2
				1	Continuous operation for group 2
		3	R/W	0*	Gradation stop or done for group 1 [1]
				1	Gradation start for group 1 [2]
		2	R/W	0*	Single shot operation for group 1
				1	Continuous operation for group 1
		1	R/W	0*	Gradation stop or done for group 0 [1]
				1	Gradation start for group 0 [2]
		0	R/W	0*	Single shot operation for group 0
				1	Continuous operation for group 0
68h	GRAD_CNTL1	7	R/W	0*	Gradation stop or done for group 5 [1]
				1	Gradation start for group 5 [2]
		6	R/W	0*	Single shot operation for group 5
				1	Continuous operation for group 5
		5	R/W	0*	Gradation stop or done for group 4 [1]
				1	Gradation start for group 4 [2]
		4	R/W	0*	Single shot operation for group 4
				1	Continuous operation for group 4
		3:0	R	0*	Reserved

When the gradation operation is forced to stop, the output current stops immediately and is frozen at the last output level.

This bit is self-cleared when a single mode is completed. Writing 0 to this bit forces to stop the gradation operation when single mode is not completed or continuous mode is running.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

7.2.8.8 Ramp control: Equation and calculation example

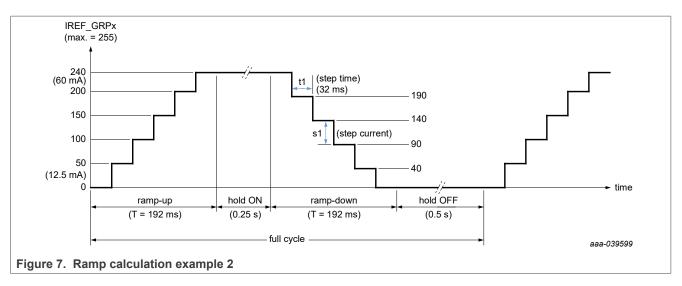


- t1 (step time) = cycle time × multiple factor, where:
 - Cycle time = 0.5 ms (fast ramp) or 8 ms (slow ramp) in STEP_TIME_GRPx[6]
 - Multiple factor = 6-bit, from 1 (00h) to 64 (3Fh) counts in STEP_TIME_GRPx[5:0]
- s1 (step current) = ramp_rate × I_{ref}, where:
 - ramp_rate = 6-bit, from 1 (00h) to 64 (3Fh) counts in RAMP_RATE_GRPx[5:0]
 - I_{ref} = reference current of 250 μ A if REXT = 1 $k\Omega$
- S (total steps) = (IREF_GRPx / ramp_rate), where:
 - IREF_GRPx = output current gain setting, 8-bit, up to 255 counts
 - ramp rate = 6-bit, up to 64 counts in RAMP RATE GRPx[5:0]
 - If it is not an integer, then round up to the next integer number.
- T (ramp time) = (S (total steps) + 1) × t1 (step time)
 - Ramp-up time starts from zero current and ends at the maximum current
 - Ramp-down time starts from the maximum current and ends at the zero current

Calculation example 1 (Figure 6):

- · Assumption:
 - I_{ref} = 250 μ A if REXT = 1 $k\Omega$
 - Output hold ON current = 250 μ A × 250 = 62.5 mA (IREF GRPx[7:0] = FAh)
 - Cycle time = 0.5 ms (STEP TIME GRPx[6] = 0)
 - Multiple factor = 64 (STEP_TIME_GRPx[5:0] = 3Fh)
 - Ramp rate = 50 (RAMP_RATE_GRPx[5:0] = 31h)
 - Hold ON = 0.25 s (HOLD CNTL GRPx[5:3] = 001)
 - Hold OFF = 0.5 s (HOLD CNTL GRPx[2:0] = 010)
- t1 (step time) = cycle time (0.5 ms) × multiple (64) = 32 ms
- Step current = ramp_rate × I_{ref} = 50 × 250 μA = 12.5 mA
- S (total steps) = (IREF_GRPx ÷ ramp_rate) = (250 ÷ 50) = 5 steps
- T (ramp time) = $(S + 1) \times t1 = 6 \times 32 \text{ ms} = 192 \text{ ms}$

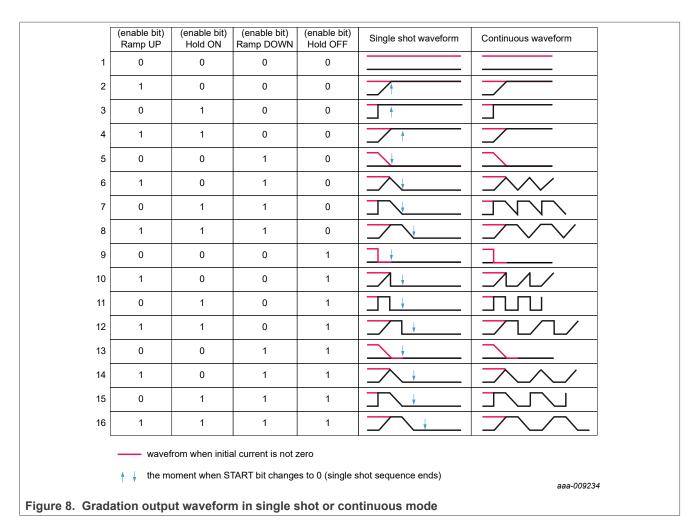
24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



Calculation example 2:

- · Assumption:
 - I_{ref} = 250 μ A if REXT = 1 $k\Omega$
 - Output hold ON current = 250 μ A × 240 = 60 mA (IREF GRPx[7:0] = F0h)
 - Cycle time = 0.5 ms (STEP_TIME_GRPx[6] = 0)
 - Multiple factor = 64 (STEP TIME GRPx[5:0] = 3Fh)
 - Ramp rate = 50 (RAMP_RATE_GRPx[5:0] = 31h)
 - Hold ON = 0.25 s (HOLD CNTL GRPx[5:3] = 001)
 - Hold OFF = 0.5 s (HOLD CNTL GRPx[2:0] = 010)
- t1 (step time) = cycle time (0.5 ms) × multiple (64) = 32 ms
- Step current = ramp rate × I_{ref} = 50 × 250 μA = 12.5 mA (except the last one)
- S (total steps) = IREF_GRPx ÷ ramp_rate = 240 ÷ 50 = 4.8 steps (round up to next integer) = 5 steps
- T (ramp time) = (S + 1) × t1 = 6 × 32 ms = 192 ms

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



7.2.9 OFFSET: LEDn output delay offset register

Table 19. OFFSET - LEDn output delay offset register (address 69h) bit description Legend: * default value.

Address	Register	Bit	Access	Value	Description
69h	OFFSET	7:4	Read only	0000*	Not used
		3:0	R/W	1000*	LEDn output delay offset factor (0000 – 1011)

PCA9958 can be programmed to have turn-on delay between LED outputs. This operation helps to reduce peak current for the V_{DD} supply and reduces EMI.

This turn-on delay also applies to $\overline{\text{OE}}$ pin when becomes low.

The order in which the LED outputs are enabled is always the same (channel 0 enables first and channel 23 enables last).

OFFSET control register bits [3:0] determine the delay used between the turn-on times as follows, and the valid number is 0000 - 1011. The number greater than 1011 (such as 1100 to 1111) has the same turn-on delay time as 1011 setting (1.375 μ S), and the read back value changes to 1011:

0000 = no delay between outputs (all on, all off at the same time)

0001 = delay of 1 clock cycle (125 ns) between successive outputs

PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

```
0010 = delay of 2 clock cycles (250 ns) between successive outputs 0011 = delay of 3 clock cycles (375 ns) between successive outputs : 1011 = delay of 11 clock cycles (1.375 μs) between successive outputs : 1111 = delay of 11 clock cycles (1.375 μs) between successive outputs
```

Example: If the value in the OFFSET register is 1000, the corresponding delay = 8×125 ns = 1 μ s delay between successive outputs.

Channel 0 turns on at time 0 µs. Channel 1 turns on at time 1 µs. Channel 2 turns on at time 2 µs. Channel 3 turns on at time 3 µs. Channel 4 turns on at time 4 µs. Channel 5 turns on at time 5 µs. Channel 6 turns on at time 6 µs. Channel 7 turns on at time 7 µs. Channel 8 turns on at time 8 µs. Channel 9 turns on at time 9 µs. Channel 10 turns on at time 10 µs. Channel 11 turns on at time 11 µs. Channel 12 turns on at time 12 µs. Channel 13 turns on at time 13 µs. Channel 14 turns on at time 14 µs. Channel 15 turns on at time 15 µs. Channel 16 turns on at time 16 µs. Channel 17 turns on at time 17 µs. Channel 18 turns on at time 18 µs. Channel 19 turns on at time 19 µs. Channel 20 turns on at time 20 µs. Channel 21 turns on at time 21 µs. Channel 22 turns on at time 22 µs. Channel 23 turns on at time 23 µs.

7.2.10 PWMALL: Brightness control for all LEDn outputs

When programmed, the value in this register is used for the PWM duty cycle for all LEDn outputs and are reflected in PWM0 through PWM23 registers.

Table 20. PWMALL - brightness control for all LEDn outputs register (address 6Ah) bit description Legend: * default value.

Address	Register	Bit	Access	Value	Description
6Ah	PWMALL	7:0	Write only	0000 0000*	Duty cycle for all LEDn outputs

Remark: Write to any of the PWM0 to PWM23 registers overwrite the value in the corresponding PWMn register programmed by PWMALL.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

7.2.11 IREFALL register: Output current value for all LED outputs

The output current setting for all outputs is held in this register. When this register is written to or updated, all LED outputs are set to a current corresponding to this register value.

Writes to IREF0 to IREF23 overwrites the output current settings.

Table 21. IREFALL - Output gain control for all LED outputs (address 6Bh) bit description Legend: * default value.

Address	Register	Bit	Access	Value	Description
6Bh	IREFALL	7:0	Write only	00h*	Current gain setting for all LED outputs.

7.2.12 LED driver constant current outputs

In LED display applications, PCA9958 provides no current variations. The absolute accuracy is less than \pm 7.5 % with 60 mA output current or \pm 9 % absolute with 30 mA output current.

7.2.12.1 Adjusting output current

PCA9958 scales up the reference current (I_{ref}) set by the external resistor (R_{ext}) to sink the output current (I_O) at each output port. The maximum output current for the outputs can be set using R_{ext} . In addition, the constant value for the current drive at each of the outputs is independently programmable using command registers IREF0 to IREF23. Alternatively, programming the IREFALL register allows all outputs to be set at one current value determined by the value in the IREFALL register. Equation 4 and Equation 5 can be used to calculate the minimum and maximum constant current values that can be programmed for the outputs for a chosen R_{ext} .

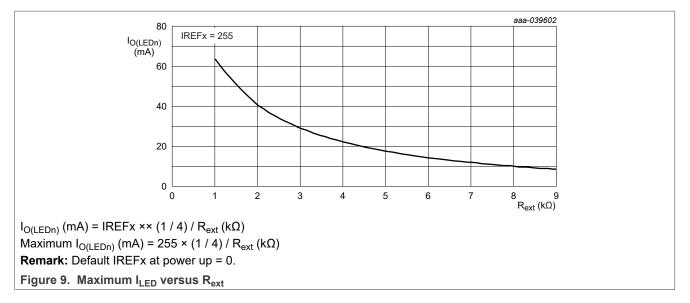
$$I_{O}_LED_MIN = \frac{1000mV}{R_{ext}} \times \frac{1}{4} \text{ (minimum constant current)}$$
 (4)

$$I_{O}_LED_MAX = (255 \times I_{O}_LED_MIN) = (\frac{1000mV}{R_{ext}} \times \frac{255}{4})$$
 (5)

For a given IREFx setting,

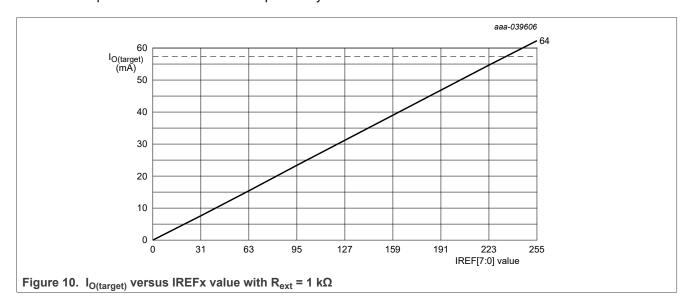
$$I_{O}_LED = IREFx \times \frac{1000mV}{R_{ext}} \times \frac{1}{4}$$

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



Example 1: If $R_{ext} = 1 k\Omega$, I_{O} LED_MIN = 250 μ A, I_{O} LED_MAX = 63.75 mA (as shown in <u>Figure 10</u>).

Each channel can be programmed with its individual IREFx in 256 steps and in 250 μ A increments to a maximum output current of 63.75 mA independently.



7.2.13 LED error detection

PCA9958 can detect an LED open or a short condition at its open-drain LED outputs. Users recognize these faults by reading the status of error bits' (ERRx) pairs in error flag registers (EFLAGn) for each channel. Both the LDRx value in LEDOUTx registers and the IREFx value must be set to '00' for those unused LED output channels. If the output is selected to be fully on, individual dim, or individual and group dim, that channel is tested.

The user can poll the ERROR status bit (bit 6 in the MODE2 register) to check if there is a fault condition in any of the 24 channels. The EFLAGn registers can then be read to determine which channels are at fault and the type of fault in those channels. The error status reported by the EFLAGn register is real time information. When AUTO_SWITCHOFF_DIS = 1, it gets self-cleared once the error is fixed or write '1' to CLRERR bit (bit 4

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

in MODE2 register). When AUTO_SWITCHOFF_DIS = 0, PCA9958 stops detection once error occurs and the EFLAGn register keeps the last error status until write '1' to CLRERR bit or get reset.

Remark: When LED outputs programmed with LDRx = 10 or 11 in LEDOUT[3:0] registers, checks for open and short-circuit do not occur if the PWM value in PWM0 to PWM23 registers is less than 8 or 255 (100 % duty cycle).

Table 22. EFLAG0 to EFLAG5 - Error flag registers (address 02h to 07h) bit description Legend: * default value.

Address	Register	Bit	Symbol	Access	Value	Description
02h	EFLAG0	7:6	ERR3	R only	00*	Error status for LED3 output
		5:4	ERR2	R only	00*	Error status for LED2 output
		3:2	ERR1	R only	00*	Error status for LED1 output
		1:0	ERR0	R only	00*	Error status for LED0 output
03h	EFLAG1	7:6	ERR7	R only	00*	Error status for LED7 output
		5:4	ERR6	R only	00*	Error status for LED6 output
		3:2	ERR5	R only	00*	Error status for LED5 output
		1:0	ERR4	R only	00*	Error status for LED4 output
04h	EFLAG2	7:6	ERR11	R only	00*	Error status for LED11 output
		5:4	ERR10	R only	00*	Error status for LED10 output
		3:2	ERR9	R only	00*	Error status for LED9 output
		1:0	ERR8	R only	00*	Error status for LED8 output
05h	EFLAG3	7:6	ERR15	R only	00*	Error status for LED15 output
		5:4	ERR14	R only	00*	Error status for LED14 output
		3:2	ERR13	R only	00*	Error status for LED13 output
		1:0	ERR12	R only	00*	Error status for LED12 output
06h	EFLAG4	7:6	ERR19	R only	00*	Error status for LED19 output
		5:4	ERR18	R only	00*	Error status for LED18 output
		3:2	ERR17	R only	00*	Error status for LED17 output
		1:0	ERR16	R only	00*	Error status for LED16 output
07h	EFLAG5	7:6	ERR23	R only	00*	Error status for LED23 output
		5:4	ERR22	R only	00*	Error status for LED22 output
		3:2	ERR21	R only	00*	Error status for LED21 output
		1:0	ERR20	R only	00*	Error status for LED20 output

Table 23. ERRx bit description

LED error detection status	ERRx		Description
	Bit 1	Bit 0	
No error	0	0	In normal operation and no error
Short-circuit	0	1	Detected LED short-circuit condition

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 23. ERRx bit description...continued

LED error detection status	ERRx		Description
	Bit 1	Bit 0	
Open-circuit	1	0	Detected LED open-circuit condition
DNE (Do Not Exist)	1	1	This condition does not exist

7.2.13.1 Open-circuit detection principle

PCA9958 LED open-circuit detection compares the effective current level I_O with the open load detection threshold current $I_{th(det)}$. If I_O is below the threshold $I_{th(det)}$, PCA9958 detects an open load condition. This error status can be read out as an error flag through the EFLAGn registers. For open-circuit error detection of an output channel, that channel must be ON.

Table 24. Open-circuit detection

State of output port	Condition of output current	Error status code	Description
OFF	I _O = 0 mA	0	Detection not possible
ON	I _O < I _{th(det)} ^[1]	1	Open-circuit
	I _O ≥ I _{th(det)} [1]	This channel open error status bit is 0	Normal

^[1] $I_{th(det)} = 0.5 \times I_{O(target)}$ (typical). This threshold can be different for each I/O and only depends on IREFx and R_{ext}

7.2.13.2 Short-circuit detection principle

The LED short-circuit detection compares the effective output voltage level (V_O) with the shorted-load detection threshold voltages $V_{th(trig)}$. If V_O is above the $V_{th(trig)}$ threshold, PCA9958 detects a shorted-load condition. If V_O is below the $V_{th(trig)}$ threshold, no error is detected and the error bit is set to '0'. This error status can be read out as an error flag through the EFLAGn registers. For short-circuit error detection of an output channel, that channel must be ON.

Table 25. Short-circuit detection

Table 20. Official discostori					
State of output port	Condition of output voltage	Error status code	Description		
OFF	-	0	Detection not possible		
ON	$V_O \ge V_{th(trig)}^{[1]}$	1	Short-circuit		
	$V_{O} < V_{th(trig)}$ ^[1]	This channel short error status bit is 0	Normal		

^[1] $V_{th} \cong 1.96 \text{ V}.$

Remark: The error status distinguishes between an LED short condition and an LED open condition. Upon detecting an LED short or open, the corresponding LED outputs must be turned OFF to prevent heat dissipation for a short in the chip. Although an open event is not harmful, the outputs must be turned OFF for both occasions to repair the LED string.

7.2.14 Overtemperature protection

If PCA9958 chip temperature exceeds its limit ($T_{th(otp)}$ (rising) maximum), all output channels are disabled until the temperature drops below its limit minus a small hysteresis ($T_{th(otp)}$ (hysteresis) maximum). For more details, see <u>Table 29</u>). When an overtemperature situation is encountered, the OVERTEMP flag (bit 7) is set in the

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

MODE2 register. Once the die temperature reduces below the $T_{th(otp)}$ rising - $T_{th(otp)}$ hysteresis, the chip returns to the same condition it was prior to the overtemperature event and the OVERTEMP flag are cleared.

7.3 Active LOW output enable input

The active LOW output enable (OE) pin on PCA9958 allows enabling/disabling the LED outputs at the same time

- When a LOW level is applied to $\overline{\text{OE}}$ pin, all the LED outputs are enabled, LEDn output delay applies to this sequence.
- When a HIGH level is applied to an $\overline{\text{OE}}$ pin, all the LED outputs are high-impedance.

The $\overline{\text{OE}}$ pin can be used as a synchronization signal to switch on/off several PCA9958 devices at the same time when LED drive output state is set fully ON (LDRx = 01 in LEDOUTx register) in these devices. This operation requires an external clock reference that provides the blinking period and the duty cycle.

The $\overline{\text{OE}}$ pin can also be used as an external dimming control signal. The frequency of the external clock must be high enough not to be seen by the human eye. The duty cycle value determines the brightness of the LEDs.

LEDn output delay controlled by register OFFSET also applies \overline{OE} control.

Remark: Do not use \overline{OE} as an external blinking control signal when internal global blinking is selected (DMBLNK = 1, MODE2 register) since it results in an undefined blinking pattern. Do not use \overline{OE} as an external dimming control signal when internal global dimming is selected (DMBLNK = 0, MODE2 register) since it results in an undefined dimming pattern.

7.4 Power-on reset

When power is applied to V_{DD} , an internal power-on reset holds PCA9958 in a reset condition until V_{DD} has reached V_{POR} . At this point, the reset condition is released and PCA9958 registers and serial bus state machine are initialized to their default states (all zeroes) causing all the channels to be deselected. Thereafter, V_{DD} must be pulled lower than 1 V and stay LOW for longer than 20 μ s. The device resets itself. Allow 2 ms for the device to wake up fully.

7.5 Hardware reset recovery

When a reset of PCA9958 is activated using an active LOW input on the RESET pin, a reset pulse width of 2.5 µs minimum is required. The maximum wait time, after the RESET pin is released, is 1.5 ms.

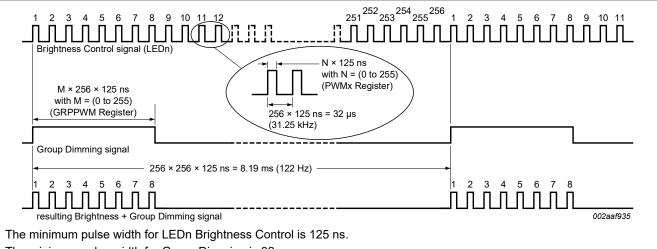
7.6 Individual brightness control with group dimming/blinking

A 31.25 kHz fixed frequency signal with programmable duty cycle (8 bits, 256 steps) is used to control individually the brightness for each LED.

On top of this signal, one of the following signals can be superimposed (this signal can be applied to the 24 LED outputs LED0 to LED23).

- A lower 122 Hz fixed frequency signal with a programmable duty cycle (8 bits, 256 steps) is used to provide a global brightness control.
- A programmable frequency signal from 15 Hz to every 16.8 seconds (8 bits, 256 steps) with programmable duty cycle (8 bits, 256 steps) is used to provide a global blinking control.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



The minimum pulse width for Group Dimming is 32 µs.

When M = 1 (GRPPWM register value), the resulting LEDn Brightness Control + Group Dimming signal have 1 pulse of the LED Brightness Control signal (pulse width = $N \times 125$ ns, with 'N' defined in PWMx register).

This resulting Brightness + Group Dimming signal above shows a resulting Control signal with M = 8.

Figure 11. Brightness + Group Dimming signals

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

8 Characteristics of the 4-wire SPI serial-bus interface

PCA9958 communicates through a daisy-chain SPI-compatible 4-wire serial interface. The interface has three inputs and one output: serial clock (SCLK), active LOW chip select (\overline{CS}), serial data in (SDI) and serial data output (SDO). \overline{CS} must be LOW to clock data into the device, and SDI must be stable when sampled on the rising edge of SCLK. PCA9958 ignores all activity on SCLK and SDI except when \overline{CS} is LOW.

8.1 SPI-compatible 4-wire serial interface signals

CS

The active LOW chip select line is used to activate and access the SPI targets. As long as \overline{CS} is HIGH, all targets do not accept the clock signal or data, and output SDO is driven LOW, therefore SPI parallel connection is not supported. Whenever this pin is in a logic LOW state, data can be transferred between the controller and all targets.

SCLK

A serial clock is provided by an SPI controller and determines the speed of the data transfer. All receiving and sending data are done synchronously (clocks the internal SPI shift register and the output driver) to this clock.

SDI

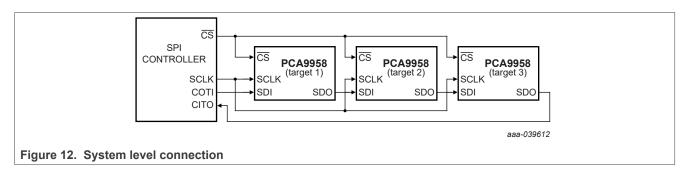
Serial Data In is read on the rising edge of SCLK into the internal 16-bit shift registers. On the rising edge of CS, the input data is latched into the internal registers of the device. The device ignores all activity on SDI when \overline{CS} is de-asserted.

SDO

Serial Data Out is the pin on which the internal 16-bit shift registers data is shifted out serially. SDO is driven LOW until the \overline{CS} pin goes to a logic LOW state. New data appears at the SDO pin following the falling edge of SCLK

All target devices can be daisy-chained by connecting the SDO of one device to the SDI of the next device, and driving SCLK and \overline{CS} lines in parallel. Figure 12 depicts how the targets are connected to the controller. All target devices are accessed at the same time with \overline{CS} . An access requires (16 × n) clock cycles, where 'n' is the number of target devices. As long as \overline{CS} is LOW, the SPI registers are working as simple shift registers and shifting through the SDI data without interpreting the different control and data bits. When \overline{CS} goes back to HIGH, the bits in the SPI registers are interpreted and the SPI logic is activated.

Only the first target in the chain receives the control and data bits directly from the SPI controller. Every other target in the network receives its SDI data from the SDO output of the preceding target in the chain, and the SDO of the last target is then connected to the data input (CITO) of the SPI controller. Each target has 16-bit shift registers shifted in from SDI and shifted out to SDO, along with the SCLK clock. The whole chain acts as a 48-bit (n × 16-bit, where 'n' is number of targets) big shift register.

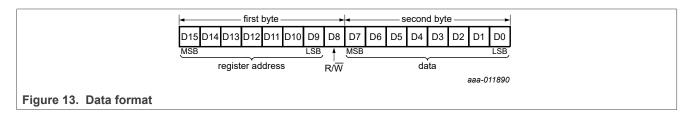


PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

8.2 Data format

As shown in Figure 13, the data transfers are 16-bit × n bits wide (where 'n' is the number of targets) with MSB transferred first. The first 7 bits, D[15:9], from the address of the register to be accessed, the eighth bit (D8) indicates the types of access, either read (= 1) or write (= 0), and the last 8 bits, D[7:0], consist of data. Register read and write sequences (described in the following sections) always begin from the bus idle condition. The bus idle condition refers to \overline{CS} being HIGH and SCLK being in a LOW state.

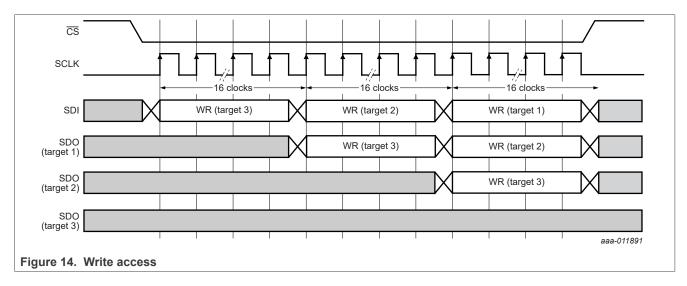


8.3 Write access sequence

The registers are written using the following write sequence (from a bus idle condition) when the system has three targets daisy-chained together:

- 1. All the target devices in the chain are involved in a write or read operation. Every target device in the chain is a portion of one big shift register.
- 2. Drive $\overline{\text{CS}}$ LOW. This operation enables the internal 16-bit shift register.
- 3. Shift (16 × n) bits of data (where 'n' is the number of targets) into the first target device in a MSB-first fashion. Data is shifted on the rising edge of SCLK and must be stable during the rising edge of SCLK.
- 4. The eighth bit of the data for every 16 bits (each device) must be a '0', indicating it is a write transfer.
- 5. After the last bit of data is transferred, drive SCLK LOW and de-assert CS (drive it HIGH).
- 6. When CS goes from LOW to HIGH, the data in the shift register is latched into the device registers.

If fewer than 16 bits of data are transferred before de-asserting \overline{CS} , then the data is ignored and the register is not updated. The write transfer format is shown in Figure 14.



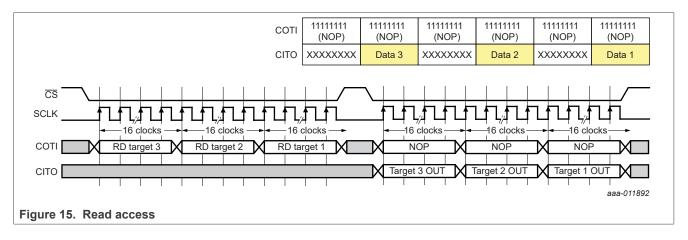
8.4 Read access sequence

The registers are read using the following read sequence (from a bus idle condition) when the system has three targets daisy-chained as shown in <u>Figure 15</u>.

PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

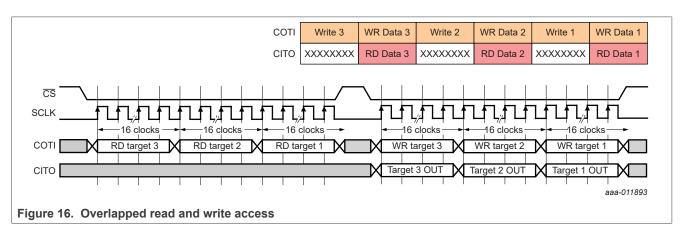
- 1. The controller sends the first three 2-byte read instructions with 48 clocks, where the first byte is a 7-bit register address, an eighth bit set to one, followed by dummy data byte (all ones).
- 2. The Read instruction is decoded when \overline{CS} is de-asserted (from LOW to HIGH).
- 3. The read data is shifted out on SDO when \overline{CS} is asserted again (from HIGH to LOW).
- 4. The controller sends the second three 2-byte 'No Operation' (NOP) operations (all ones) with 48 clocks and reads the requested data on CITO in sequence where the first byte is dummy data (don't care), followed by the read data byte.
- 5. A read cycle consists of asserting and de-asserting of CS twice.



8.5 Overlapped read and write access sequence

The registers are read and write overlapped using the following sequence (from a bus idle condition) when the system has three targets daisy-chained as shown in Figure 16.

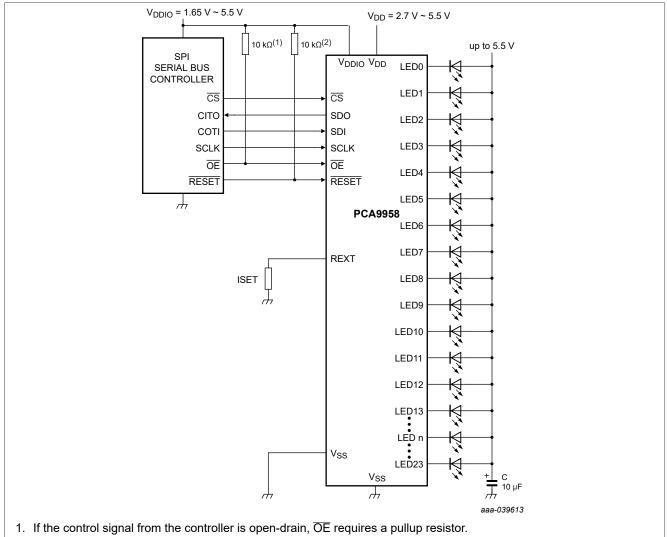
- 1. The second phase of the read cycle can be used to send in write data or the next read instruction. This increases the bus utility and therefore efficiency.
- 2. The controller sends the first three 2-byte read instructions with 48 clocks, where the first byte is a 7-bit register address, the eighth bit is set to one, followed by dummy data byte (all ones).
- 3. The read instruction is decoded when $\overline{\text{CS}}$ is de-asserted (from LOW to HIGH).
- 4. Start to shift read data out on SDO when $\overline{\text{CS}}$ is asserted again (from HIGH to LOW) and start to send in the next read or write instruction on the SDI line.



24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

9 Application design-in information

Figure 17 shows the typical application of PCA9958.



2. If not used or connected to an open-drain output, \overline{RESET} requires a pullup resistor of <100 k Ω .

Figure 17. Typical application

9.1 Thermal considerations

Since PCA9958 device integrates 24 linear current sources, thermal considerations must be considered to prevent overheating, which can cause the device to go into thermal shutdown.

Perhaps the major contributor for overheating of device is the LED forward voltage mismatch. It can cause significant voltage differences between the LED of the same type (for example, 2 V to 3 V), which ultimately translates into higher power dissipation in the device. The voltage drop across the LED channels of the device is given by the difference between the supply voltage and LED forward voltage of each LED. Reducing this value to a minimum (for example, 0.5 V) helps to keep the power dissipation down. Therefore, LEDs binning is recommended to minimize LED voltage forward variation and reduce power dissipation in the device.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

To ensure that the device does not go into thermal shutdown when operating under certain application conditions, its junction temperature (T_j) must be calculated to ensure that it is below the overtemperature threshold limit (130 °C for PCA9958HN or 140 °C for PCA9958HN/Q900). The T_j of the device depends on the ambient temperature (T_{amb}) , total power dissipation of the device (P_{tot}) , and thermal resistance.

The device junction temperature can be calculated by using the following equation:

$$T_i = T_{amb} + R_{th(i-a)} \times P_{tot} \tag{6}$$

Where:

 T_j = junction temperature T_{amb} = ambient temperature $R_{th(j-a)}$ = junction to ambient thermal resistance P_{tot} = (device) total power dissipation

An example of this calculation is shown below:

Conditions:

```
\begin{split} &T_{amb} = 50 \text{ °C} \\ &R_{th(j-a)} = 36.8 \text{ °C/W (per JEDEC 51 standard for multilayer PCB)} \\ &I_{LED} = 60 \text{ mA / channel} \\ &I_{DD(max)} = 20 \text{ mA} \\ &V_{DD} = 3.3 \text{ V} \\ &LEDs \text{ per channel } = 1 \text{ LEDs / channel} \\ &LED \text{ V}_{F(typ)} = 3 \text{ V per LED} \\ &LED \text{ V}_F \text{ mismatch } = 0.2 \text{ V per LED} \\ &LED \text{ V}_{Feg(drv)} = 0.5 \text{ V (Present only in the LED string with the highest LED forward voltage.)} \\ &V_{sup} = \text{LED V}_{F(typ)} + \text{LED V}_F \text{ mismatch } + \text{V}_{reg(drv)} = 3 \text{ V} + 0.2 \text{ V} + 0.5 \text{ V} = 3.7 \text{ V} \end{split}
```

P_{tot} calculation:

```
\begin{split} &P_{tot} = IC\_power + LED \ drivers\_power; \\ &IC\_power = (I_{DD} \times V_{DD}) \\ &IC\_power = (0.02 \ A \times 3.3 \ V) = 0.066 \ W \\ &LED \ drivers\_power = [(24 - 1) \times (I_{LED}) \times (LED \ V_F \ mismatch + V_{reg(drv)})] + (I_{LED} \times V_{reg(drv)}) \\ &LED \ drivers\_power = [23 \times 0.06 \ A \times (0.2 \ V + 0.5 \ V)] + (0.06 \ A \times 0.5 \ V)] = 0.996 \ W \\ &P_{tot} = 0.066 \ W + 0.996 \ W = 1.062 \ W \end{split}
```

T_i calculation:

```
T_j = T_{amb} + R_{th(j-a)} \times P_{tot}

T_i = 50 \text{ °C} + (36.8 \text{ °C/W} \times 1.062 \text{ W}) = 89.08 \text{ °C}
```

This value confirms that the junction temperature is below the minimum overtemperature threshold of 130 $^{\circ}$ C for PCA9958HN or 140 $^{\circ}$ C for PCA9958HN/Q900. It ensures that the device does not go into thermal shutdown under these conditions.

It is important to mention that the value of the thermal resistance junction-to-ambient ($R_{th(j-a)}$) strongly depends in the PCB design. Therefore, the thermal pad of the device must be attached to a big enough PCB copper area, ensuring proper thermal dissipation (similar to JEDEC 51 standard). Several thermal vias in the PCB thermal pad must be used as well to increase the effectiveness of the heat dissipation (for example, 15 thermal vias). The thermal vias must be distributed evenly in the PCB thermal pad.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Finally, it is important to point out that this calculation must be taken as a reference only. Therefore, evaluations must still be performed under the application environment and conditions to confirm proper system operation.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

10 Limiting values

This section describes the limiting values of PCA9958.

Table 26. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V_{DD}	Supply voltage		-0.5	+6.0	V
V_{DDIO}	Supply voltage of interface		-0.5	+6.0	V
V _{I/O}	Voltage on an input/output pin		V _{SS} - 0.5	5.5	V
V _{drv(LED)}	LED driver voltage		V _{SS} - 0.5	+6.0	V
I _{O(LEDn)}	Output current on pin LEDn		-	70	mA
I _{SS}	Ground supply current		-	1.0	Α
P _{tot}	Total power dissipation	T _{amb} = 25 °C	-	3.3	W
		T _{amb} = 85 °C	-	1.3	W
T _{stg}	Storage temperature		-65	+150	°C
T _{amb}	Ambient temperature	Operating for non AEC-Q100	-40	+85	°C
		Operating for AEC-Q100	-40	+125	°C
T _j	Junction temperature		-	+160	°C

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

11 Thermal characteristics

This section describes the thermal characteristics of PCA9958.

Table 27. Thermal characteristics

Symbol	Parameter	Conditions		Тур	Unit
$R_{th(j-a)}$	Thermal resistance from junction to ambient	HVQFN40	[1]	36.8	°C/W
R _{th(j-case top)}	Thermal resistance between the junction and the case top	HVQFN40		18.1	°C/W
R _{th(j-case bottom)}	Thermal resistance between the junction and the case bottom	HVQFN40		11.2	°C/W

^[1] Per JEDEC 51 standard for multilayer PCB and Wind Speed (m/s) = 0.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

12 Static characteristics

This section describes the static characteristics of PCA9958.

Table 28. Static characteristics (PCA9958HN)

 V_{DD} = 2.7 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ^[1]	Max	Unit
Supply						'	
V_{DD}	Supply voltage			2.7	-	5.5	V
V_{DDIO}	Supply voltage of SPI interface			1.65	-	5.5	V
I _{DD}	Supply current	On pin V_{DD} ; operating mode; $f_{SCLK} = 10 \text{ MHz}$					
		R_{ext} = 1 kΩ; LED[23:0] = off; IREFx = 00h		-	-	8.2	mA
		R_{ext} = 1 kΩ; LED[23:0] = on; IREFx = FFh		-	-	8.7	mA
I _{DDIO}	Supply current	On pin V_{DDIO} ; operating mode; $f_{SCLK} = 10$ MHz; keep writing mode register (01h) with 00h		-	-	800	μA
I _{stb}	Standby current	On pin V_{DD} ; no load; $f_{SCLK} = 0$ Hz; MODE1[4] = 1; $V_{I} = V_{DD}$					•
		V _{DD} = 3.3 V		-	170	600	μA
		V _{DD} = 5.5 V		-	170	700	μΑ
V _{POR}	Power-on reset voltage	No load; V _I = V _{DD} or V _{SS}		-	2	-	V
V _{PDR}	Power-down reset voltage	No load; V _I = V _{DD} or V _{SS}	[2] [3]	-	1	-	V
Inputs CS, SI	DI, SCLK; output SDO			1			
V _{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DDIO}	V
V _{IH}	HIGH-level input voltage			0.7V _{DDIO}	-	5.5	V
V _{OH}	HIGH-level output voltage	I _{OH} = -3 mA at SDO		0.8V _{DDIO}	-	-	V
V _{OL}	LOW-level output voltage	I _{OL} = 3 mA at SDO		-	-	0.2V _{DDIO}	V
IL	Leakage current	V _I = V _{DDIO} or V _{SS}		-1	-	+1	μA
C _i	Input capacitance	V _I = V _{SS}		-	6	10	pF
Current conti	rolled outputs (LED[2	23:0])		'	1		
I _{O(LEDn)}	Output current on pin LEDn	V_O = 0.5 V; IREFx = 80h; R_{ext} = 1 k Ω	[3]	30	32	35	mA
		V_O = 0.5 V; IREFx = FFh; R_{ext} = 1 k Ω	[3]	58	63	68	mA
ΔI _{O_Absolute}	Absolute output current variation	V_O = 0.5 V; all channels on; IREFx >= 20h R _{ext} = 1 k Ω ; refer to ideal value; guaranteed by design				±7.5	%

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 28. Static characteristics (PCA9958HN)...continued

 V_{DD} = 2.7 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +85 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ^[1]	Max	Unit
		V_O = 0.5 V; all channels on; IREFx < 20h; R_{ext} = 1 k Ω ; refer to ideal value; guaranteed by design				±9	%
ΔI _{O_mis_p2p}	Part to part output current mismatch	All channels on; IREFx = FFh. R_{ext} = 1 k Ω ; V_O = 0.5 V; average value of 24 output current of each device, compared to ideal value	[4]	-	-	±7	%
ΔI _{O_mis_c2c}	Channel-to- channel output current mismatch	All channels on; IREFx = FFh. R_{ext} = 1 k Ω ; V_{O} = 0.5 V; each channel current compared to the average current of 24 channels	[5]	-	-	±5	%
V _{reg(drv)}	Driver regulation voltage	Minimum regulation voltage; IREFx = FFh; R _{ext} = 1 kΩ		0.5		5.5	V
$I_{L(off)}$	Off-state leakage current	V _O = 5 V		-	-	1	μΑ
V_{trip}	Trip voltage	Short LED protection; Error flag trips during verification test if V_O $\geq V_{trip}$; $R_{ext} = 1 \text{ k}\Omega^{[6]}$		1.85	1.96	-	V
OE input, RES	SET input	1					
V _{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DDIO}	V
V _{IH}	HIGH-level input voltage			0.7V _{DDIO}	-	5.5	V
l _{Ll}	Input leakage current			-1	-	+1	μΑ
C _i	Input capacitance		[3]	-	3.7	5	pF
Overtemperat	ture protection						
T _{th(otp)}	Overtemperature	Rising	[3]	130	-	150	°C
	protection threshold temperature	Hysteresis	[3]	15	-	30	°C

^[1] Typical limits at V_{DD} = 3.3 V, T_{amb} = 25 °C.

$$\varDelta\% = \left(\frac{\left[\frac{lo(LED0)^{+l}o(LED1)^{+...+l}o(LED22)^{+l}o(LED23)}{24} - idealoutputcurrent}\right]}{idealoutputcurrent}\right) \times 100$$

Where 'ideal output current' = 63.75 mA (Rext = 1 k Ω , IREFx = FFh). Channel-to-channel mismatch is calculated:

$$\Delta\% = \left(\frac{I_{O(LEDn)}(\text{where n} = 0 \text{ to 23})}{\left(\frac{I_{O(LED0)}+I_{O(LED1)}+...+I_{O(LED22)}+I_{O(LED23)}}{24}\right)} - 1\right) \times 100$$

LEDx falling time must not be longer than 500 ns.

^[2] [3] V_{DD} must be lowered to 1 V to reset the part.

Value is not tested in production, but guaranteed by design and characterization.

^[4] Part-to-part mismatch is calculated:

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 29. Static characteristics (PCA9958HN/Q900)

 V_{DD} = 2.7 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +125 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ^[1]	Max	Unit
Supply							
V_{DD}	Supply voltage			2.7	-	5.5	V
$V_{\rm DDIO}$	Supply voltage of SPI interface			1.65	-	5.5	V
I _{DD}	Supply current	On pin V_{DD} ; operating mode; $f_{SCLK} = 10 \text{ MHz}$				'	•
		R_{ext} = 1 kΩ; LED[23:0] = off; IREFx = 00h		-	-	8.2	mA
		R_{ext} = 1 kΩ; LED[23:0] = on; IREFx = FFh		-	-	8.7	mA
I _{DDIO}	Supply current	On pin V_{DDIO} ; operating mode; $f_{SCLK} = 10$ MHz; keep writing mode register (01h) with 00h		-	-	800	μА
I _{stb}	Standby current	On pin V_{DD} ; no load; $f_{SCLK} = 0$ Hz; MODE1[4] = 1; $V_{I} = V_{DD}$					
		V _{DD} = 3.3 V		-	170	600	μA
		V _{DD} = 5.5 V		-	170	700	μA
V _{POR}	Power-on reset voltage	No load; V _I = V _{DD} or V _{SS}		-	2	-	V
V _{PDR}	Power-down reset voltage	No load; V _I = V _{DD} or V _{SS}	[2] [3]	-	1	-	V
Inputs CS, SI	DI, SCLK; output SDO		I				
V _{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DDIO}	V
V _{IH}	HIGH-level input voltage			0.7V _{DDIO}	-	5.5	V
V _{OH}	HIGH-level output voltage	I _{OH} = -3 mA at SDO		0.8V _{DDIO}	-	-	V
V _{OL}	LOW-level output voltage	I _{OL} = 3 mA at SDO		-	-	0.2V _{DDIO}	V
IL	Leakage current	V _I = V _{DDIO} or V _{SS}		-1	-	+1	μΑ
Ci	Input capacitance	V _I = V _{SS}		-	6	10	pF
Current cont	rolled outputs (LED[2	23:0])					
I _{O(LEDn)}	Output current on pin LEDn	$V_O = 0.5 \text{ V}$; IREFx = 80h; $R_{ext} = 1 \text{ k}\Omega$	[3]	30	32	35	mA
		$V_O = 0.5 \text{ V}$; IREFx = FFh; $R_{ext} = 1 \text{ k}\Omega$	[3]	58	63	68	mA
ΔI _{O_Absolute}	Absolute output current variation	V_O = 0.5 V; all channels on; IREFx >= 20h R _{ext} = 1 k Ω ; refer to ideal value; guaranteed by design				±7.5	%
		V_O = 0.5 V; all channels on; IREFx < 20h; R_{ext} = 1 k Ω ; refer to ideal value; guaranteed by design				±9	%

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Table 29. Static characteristics (PCA9958HN/Q900)...continued

 V_{DD} = 2.7 V to 5.5 V; V_{SS} = 0 V; T_{amb} = -40 °C to +125 °C; unless otherwise specified.

Symbol	Parameter	Conditions		Min	Typ ^[1]	Max	Unit
ΔI _{O_mis_p2p}	Part to part output current mismatch	All channels on; IREFx = FFh. R_{ext} = 1 k Ω ; V_O = 0.5 V; average value of 24 output current of each device, compared to ideal value	[4]	-	-	±7	%
ΔI _{O_mis_c2c}	Channel-to- channel output current mismatch	All channels on; IREFx = FFh. R_{ext} = 1 k Ω ; V_{O} = 0.5 V; each channel current compared to the average current of 24 channels	[5]	-	-	±5	%
V _{reg(drv)}	Driver regulation voltage	Minimum regulation voltage; IREFx = FFh; R _{ext} = 1 kΩ		0.5		5.5	V
$I_{L(off)}$	Off-state leakage current	V _O = 5 V		-	1	2.5	μА
V_{trip}	Trip voltage	Short LED protection; Error flag trips during verification test if $V_O \ge V_{trip}$; $R_{ext} = 1 \text{ k}\Omega^{[6]}$		1.85	1.96	-	V
OE input, RES	ET input					'	
V _{IL}	LOW-level input voltage			-0.5	-	+0.3V _{DDIO}	V
V _{IH}	HIGH-level input voltage			0.7V _{DDIO}	-	5.5	V
I _{LI}	Input leakage current			-1	-	+1	μА
Ci	Input capacitance		[3]	-	3.7	5	pF
Overtemperat	ure protection				•	<u>'</u>	
T _{th(otp)}	Overtemperature	Rising	[3]	140	-	160	°C
nrotection	Hysteresis	[3]	15	-	30	°C	

- Typical limits at V_{DD} = 3.3 V, T_{amb} = 25 °C. V_{DD} must be lowered to 1 V to reset the part.
- [2]
- [3] [4] Value is not tested in production, but guaranteed by design and characterization.
- Part-to-part mismatch is calculated:

$$\varDelta\% = \left(\frac{\left[\frac{lo(LED0)^{+l}o(LED1)^{+...+l}o(LED22)^{+l}o(LED23)}{24} - idealoutputcurrent}\right]}{idealoutputcurrent}\right) \times 100$$

Where 'ideal output current' = 63.75 mA (R $_{ext}$ = 1 k Ω , IREFx = FFh). Channel-to-channel mismatch is calculated:

[5]

$$\Delta\% = \left(\frac{I_{O(LEDn)}(\text{where n = 0 to 23})}{\left(\frac{I_{O(LED0)}+I_{O(LED1)}+...+I_{O(LED22)}+I_{O(LED23)}}{24}\right)} - 1\right) \times 100$$

LEDx falling time must not be longer than 500 ns.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

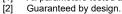
13 Dynamic characteristics

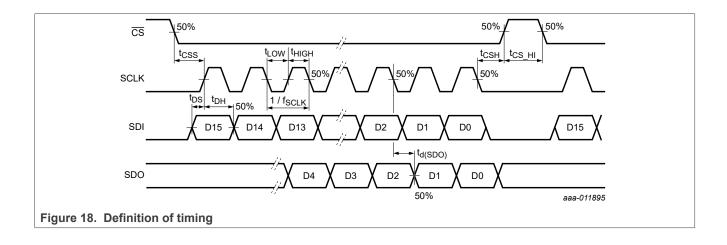
This section describes the dynamic characteristics of PCA9958.

Table 30. Dynamic characteristics^[1]

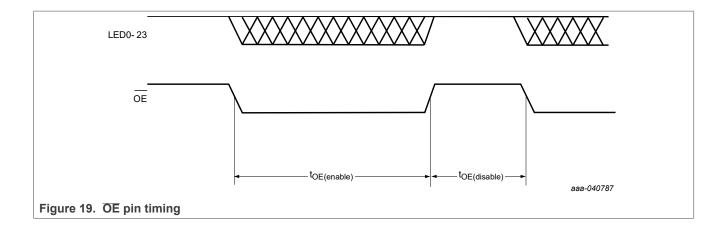
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
f _{SCLK}	SCLK clock frequency		0	-	10	MHz
t _{LOW}	LOW period of the SCLK clock		50	-	-	ns
t _{HIGH}	HIGH period of the SCLK clock		50	-	-	ns
t _{DS}	Data set-up time		10	-	-	ns
t _{DH}	Data hold time		20	-	-	ns
t _{CSS}	Chip select asserted to SCLK rise set-up time		10	-	-	ns
t _{CSH}	SCLK fall to chip select de-asserted hold time		0	-	-	ns
t _{CS_HI}	Minimum chip select de-asserted HIGH time		40	-	-	ns
t _{d(SDO)}	SDO delay time	C _L = 50 pF	-	-	40	ns
t _{d(LED0)}	The latency time between $\overline{\text{OE}}$ pin assertion to LED channel 0 output on		-	-	1 ^[2]	μs
t _{OE(disable)}	OE pin disable (HIGH) period time		250	-	-	ns
t _{OE(enable)}	OE pin enable (LOW) period time		250	-	-	ns

^[1] All parameters tested at V_{DD} = 3 V to 5.5 V; V_{SS} = 0 V; T_{amb} = +25 °C. Specifications over temperature are guaranteed by design.





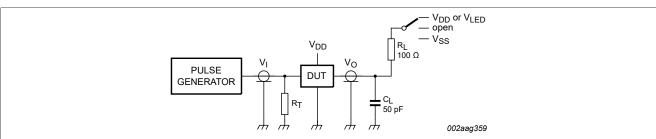
24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

14 Test information

This section contains test information related to PCA9958.



R_L = Load resistor for LEDn.

 C_L = Load capacitance includes jig and probe capacitance.

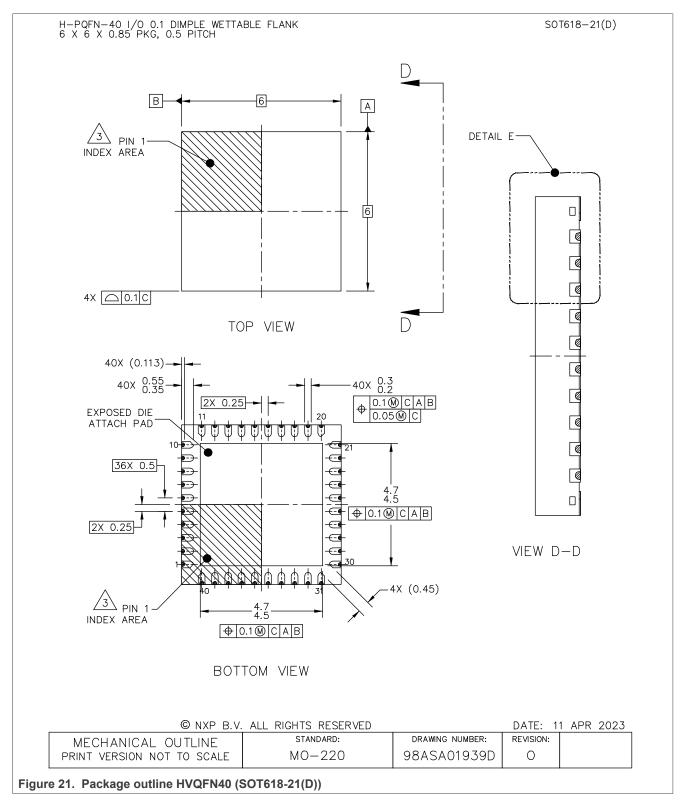
 R_T = Termination resistance must be equal to the output impedance Z_o of the pulse generators.

Figure 20. Test circuitry for switching times

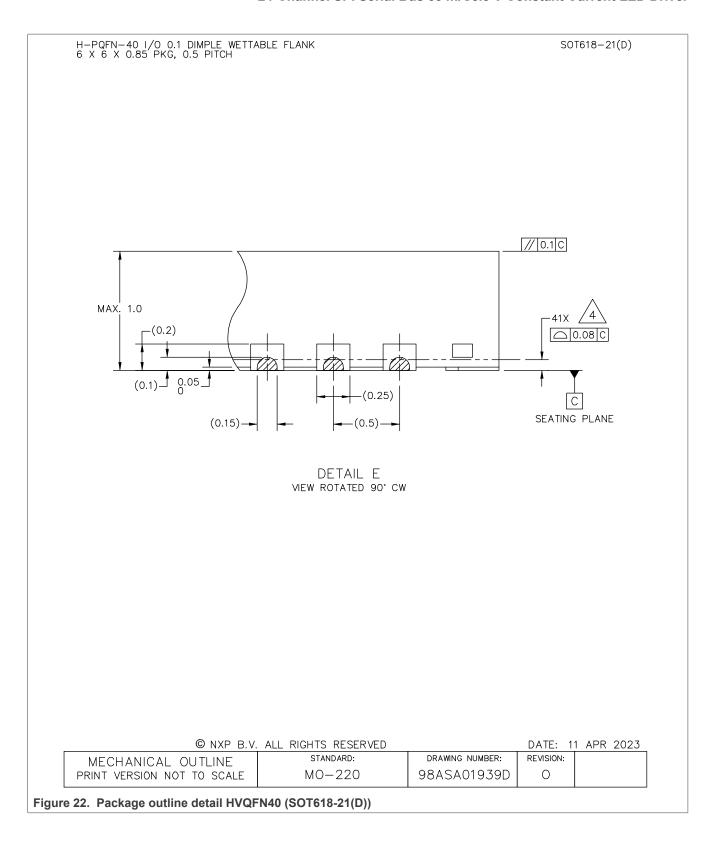
24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

15 Package information: SOT618-21(D)

15.1 Package outline



24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

H-PQFN-40 I/O 0.1 DIMPLE WETTABLE FLANK 6 X 6 X 0.85 PKG, 0.5 PITCH

SOT618-21(D)

NOTES:

- 1. ALL DIMENSIONS ARE IN MILLIMETERS.
- 2. DIMENSIONING AND TOLERANCING PER ASME Y14.5M-1994.

3. PIN 1 FEATURE SHAPE, SIZE AND LOCATION MAY VARY.

 $\sqrt{4}$ COPLANARITY APPLIES TO LEADS, ANCHORING PADS AND DIE ATTACH FLAG.

5. MIN. METAL GAP FOR LEAD TO EXPOSED PAD SHALL BE 0.2 MM.

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DATE: 11 APR 2023

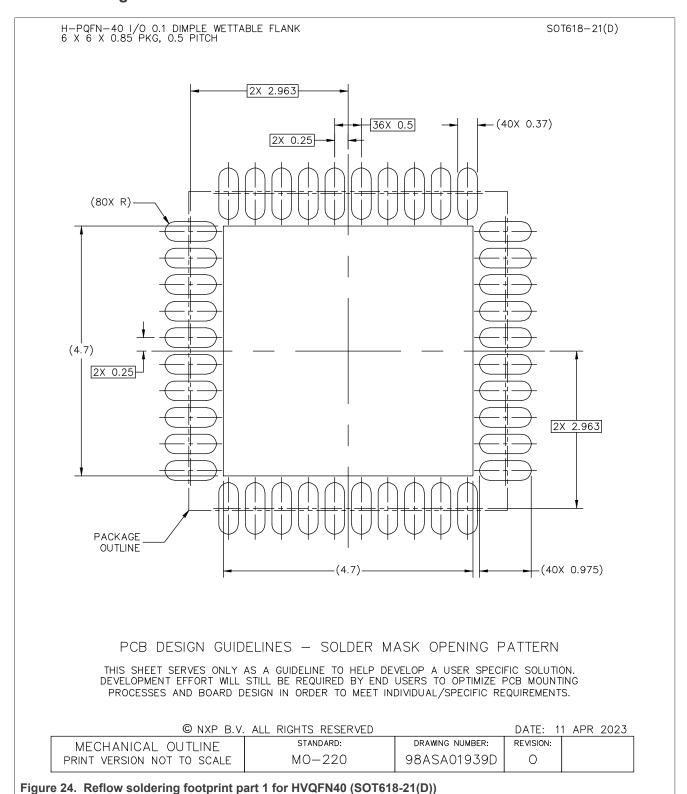
MECHANICAL OUTLINE STANDARD:
PRINT VERSION NOT TO SCALE MO-220

DRAWING NUMBER: REVISION: 98ASA01939D O

Figure 23. Package outline notes HVQFN40 (SOT618-21(D))

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

15.2 Soldering



PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

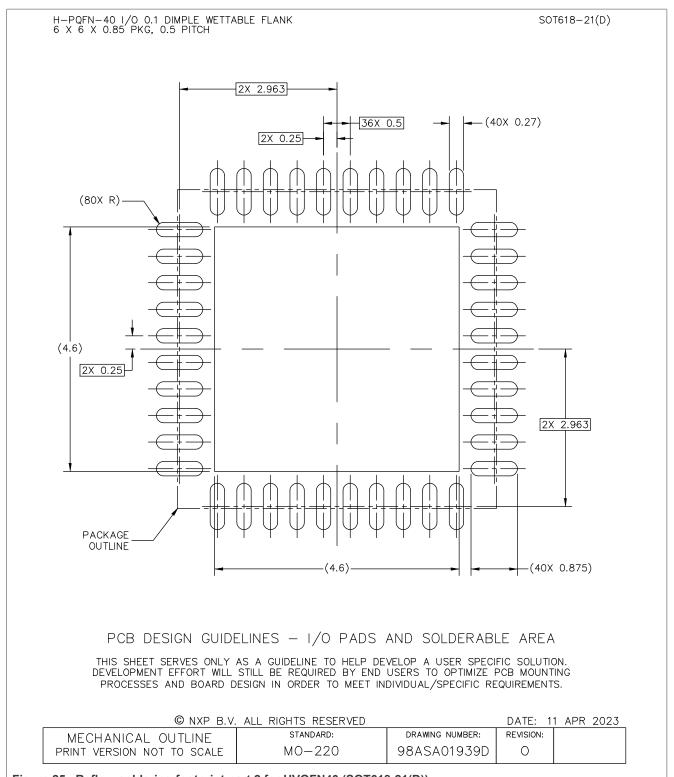
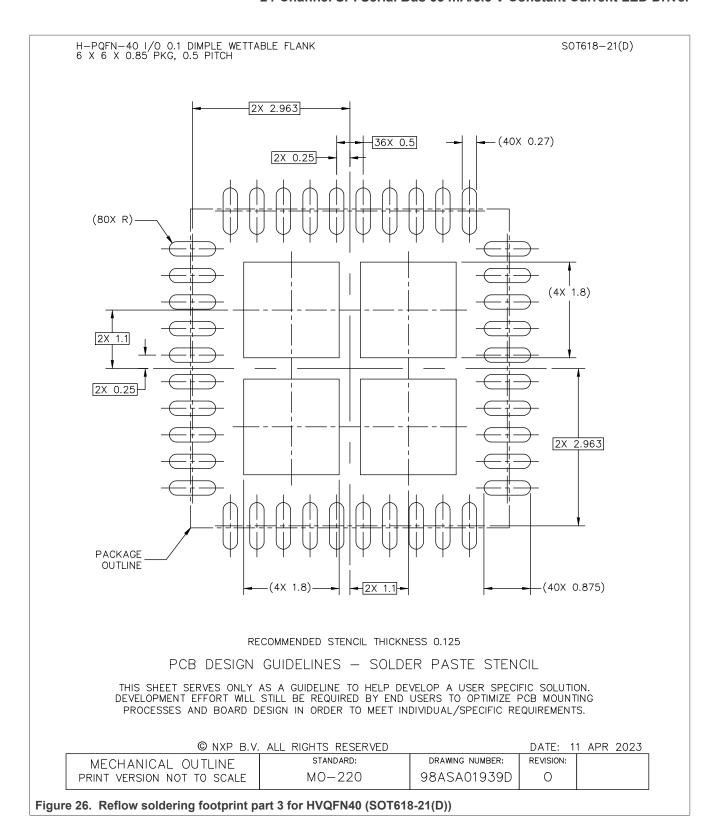


Figure 25. Reflow soldering footprint part 2 for HVQFN40 (SOT618-21(D))

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver



PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

16 Handling information

Handling information

All input and output pins are protected against ElectroStatic Discharge (ESD) under normal handling. When handling ensure that the appropriate precautions are taken as described in *JESD625-A* or equivalent standards.

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

17 Soldering of SMD packages

This text provides a very brief insight into a complex technology. A more in-depth account of soldering ICs can be found in Application Note *AN10365 "Surface mount reflow soldering description"*.

17.1 Introduction to soldering

Soldering is one of the most common methods through which packages are attached to Printed Circuit Boards (PCBs), to form electrical circuits. The soldered joint provides both the mechanical and the electrical connection. There is no single soldering method that is ideal for all IC packages. Wave soldering is often preferred when through-hole and Surface Mount Devices (SMDs) are mixed on one printed wiring board; however, it is not suitable for fine pitch SMDs. Reflow soldering is ideal for the small pitches and high densities that come with increased miniaturization.

17.2 Wave and reflow soldering

Wave soldering is a joining technology in which the joints are made by solder coming from a standing wave of liquid solder. The wave soldering process is suitable for the following:

- Through-hole components
- · Leaded or leadless SMDs, which are glued to the surface of the printed circuit board

Not all SMDs can be wave soldered. Packages with solder balls, and some leadless packages which have solder lands underneath the body, cannot be wave soldered. Also, leaded SMDs with leads having a pitch smaller than ~0.6 mm cannot be wave soldered, due to an increased probability of bridging.

The reflow soldering process involves applying solder paste to a board, followed by component placement and exposure to a temperature profile. Leaded packages, packages with solder balls, and leadless packages are all reflow solderable.

Key characteristics in both wave and reflow soldering are:

- · Board specifications, including the board finish, solder masks and vias
- Package footprints, including solder thieves and orientation
- · The moisture sensitivity level of the packages
- Package placement
- · Inspection and repair
- · Lead-free soldering versus SnPb soldering

17.3 Wave soldering

Key characteristics in wave soldering are:

- Process issues, such as application of adhesive and flux, clinching of leads, board transport, the solder wave parameters, and the time during which components are exposed to the wave
- Solder bath specifications, including temperature and impurities

17.4 Reflow soldering

Key characteristics in reflow soldering are:

- Lead-free versus SnPb soldering; note that a lead-free reflow process usually leads to higher minimum peak temperatures (see Figure 27) than a SnPb process, thus reducing the process window
- Solder paste printing issues including smearing, release, and adjusting the process window for a mix of large and small components on one board

PCA9958

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Reflow temperature profile; this profile includes preheat, reflow (in which the board is heated to the peak
temperature) and cooling down. It is imperative that the peak temperature is high enough for the solder to
make reliable solder joints (a solder paste characteristic). In addition, the peak temperature must be low
enough that the packages and/or boards are not damaged. The peak temperature of the package depends on
package thickness and volume and is classified in accordance with <u>Table 31</u> and <u>Table 32</u>

Table 31. SnPb eutectic process (from J-STD-020D)

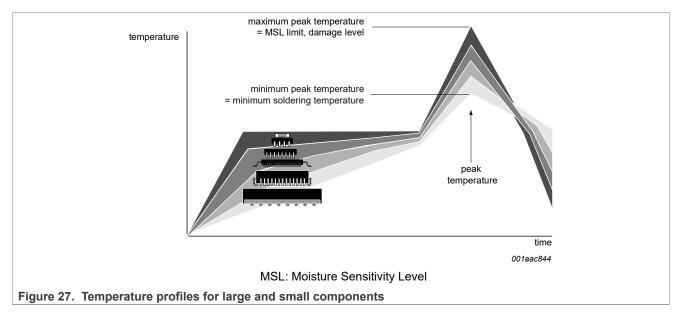
Package thickness (mm)	Package reflow temperature (°C)		
	Volume (mm³)		
	< 350	≥ 350	
< 2.5	235	220	
≥ 2.5	220	220	

Table 32. Lead-free process (from J-STD-020D)

Package thickness (mm)	Package reflow temperature (°C)				
	Volume (mm³)				
	< 350	350 to 2000	> 2000		
< 1.6	260	260	260		
1.6 to 2.5	260	250	245		
> 2.5	250	245	245		

Moisture sensitivity precautions, as indicated on the packing, must be respected at all times.

Studies have shown that small packages reach higher temperatures during reflow soldering, see Figure 27.



For further information on temperature profiles, refer to Application Note AN10365 "Surface mount reflow soldering description".

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

18 Acronyms

Table 33 describes the acronyms used in this datasheet.

Table 33. Acronyms

Acronym	Description
CDM	Charged-Device Model
DAC	Digital-to-Analog Converter
DUT	Device Under Test
ESD	ElectroStatic Discharge
FET	Field-Effect Transistor
НВМ	Human Body Model
LED	Light-Emitting Diode
LSB	Least Significant Bit
MCU	Micro Controller Unit
CITO	Controller In, Target Out
СОТІ	Controller Out, Target In
MSB	Most Significant Bit
NMOS	Negative-channel Metal-Oxide Semiconductor
РСВ	Printed-Circuit Board
PMOS	Positive-channel Metal-Oxide Semiconductor
PWM	Pulse Width Modulation
RGB	Red/Green/Blue
RGBA	Red/Green/Blue/Amber
SMBus	System Management Bus
SPI	Serial Peripheral Interface

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

19 Revision history

Table 34 summarizes revisions to this document.

Table 34. Revision history

Table 04. Revision history					
Document ID	Release date	Description			
PCA9958 v.1.2	13 November 2025	Updated per CIN #202511001I: Relabelled and updated the graph in Figure 9 Editorial fixes			
PCA9958 v.1.1	18 September 2024	<u>Section 2</u> : Added bullet specifying AEC-Q100 automotive compliance for PCA9958HN/Q900			
PCA9958 v.1.0	31 January 2024	Initial public release			

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

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Document status ^{[1][2]}	Product status ^[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

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- [2] The term 'short data sheet' is explained in section "Definitions".
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24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Tables

Tab. 1.	Ordering information	.5		4Bh, 4Fh, 53h, 57h) for each group bit	
Tab. 2.	Ordering options	.5		description	22
Tab. 3.	Pin description	.7 Ta	b. 16.	GRAD_MODE_SEL[0:1] - Gradation mode	
Tab. 4.	Register summary - default values	.9		select register for channel 23 to channel 0	
Tab. 5.	MODE1 - Mode register 1 (address 00h) bit			(address 58h, 59h, 5Ah) bit description	22
	description1	4 Ta	b. 17.	GRAD GRP SEL[0:3] - Gradation group	
Tab. 6.	MODE2 - Mode register 2 (address 01h) bit			select register for channel 23 to channel	
	description1	15		0 (address 5Bh, 5Ch, 5Dh, 5Eh, 5Fh,	
Tab. 7.	LEDOUT0 to LEDOUT5 - LED driver output			60h, 61h, 62h, 63h, 64h, 65h, 66h) bit	
	state registers (address 08h to 0Dh) bit			description	23
	description1	l6 Ta	b. 18.	GRAD CNTL[0:1] - Gradation control	
Tab. 8.	GRPPWM - Group brightness control			register for group 5 to group 0 (address	
	register (address 0Eh) bit description1	7		67h, 68h) bit description	24
Tab. 9.	GRPFREQ - Group frequency register		b. 19.	OFFSET - LEDn output delay offset	
	(address 0Fh) bit description1			register (address 69h) bit description	28
Tab. 10.	PWM0 to PWM23 - PWM registers 0 to 23		b. 20.	PWMALL - brightness control for all	
	(address 10h to 27h) bit description1			LEDn outputs register (address 6Ah) bit	
Tab. 11.	IREF0 to IREF23 - LED output gain			description	29
	control registers (address 28h to 3Fh) bit	Ta	b. 21.	IREFALL - Output gain control for all LED	
	description1			outputs (address 6Bh) bit description	30
Tab. 12.	RAMP RATE GRP[0:3] - Ramp enable		b. 22.	EFLAG0 to EFLAG5 - Error flag registers	
	and rate control registers (address 40h,			(address 02h to 07h) bit description	32
	44h, 48h, 4Ch, 50h, 54h) for each group bit	Та	b. 23.	ERRx bit description	
	description2		b. 24.	Open-circuit detection	
Tab. 13.	STEP_TIME_GRP[0:3] - Step time control		b. 25.	Short-circuit detection	
	registers (address 41h, 45h, 49h, 4Dh, 51h,	Ta	b. 26.	Limiting values	
	55h) for each group bit description2	21 Ta	b. 27.	Thermal characteristics	
Tab. 14.	HOLD CNTL GRP[0:3] - Hold ON and		b. 28.	Static characteristics (PCA9958HN)	44
	OFF enable and time control registers	Ta	b. 29.	Static characteristics (PCA9958HN/Q900)	
	(address 42h, 46h, 4Ah, 4Eh, 52h, 56h) for	Ta	b. 30.	Dynamic characteristics	
	each group bit description2	21 Ta	b. 31.	SnPb eutectic process (from J-STD-020D)	59
Tab. 15.	IREF_GRP[0:3] - Final and hold ON output		b. 32.	Lead-free process (from J-STD-020D)	
	gain setting registers (address 43h, 47h,	Ta	b. 33.	Acronyms	
		Ta	b. 34.	Revision history	61

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Figures

Fig. 1.	Plack diagram of DCA0059	Eig. 17	Typical application	39
•	Block diagram of PCA99586	Fig. 17.	Typical application	
Fig. 2.	Pin configuration	Fig. 18.	Definition of timing	
Fig. 3.	Register address and data format for each	Fig. 19.	OE pin timing	49
	target9	Fig. 20.	Test circuitry for switching times	50
Fig. 4.	Linear and exponential adjustment curves 16	Fig. 21.	Package outline HVQFN40	
Fig. 5.	Gradation timing20	· ·	(SOT618-21(D))	51
Fig. 6.	Ramp calculation example 126	Fig. 22.	Package outline detail HVQFN40	
Fig. 7.	Ramp calculation example 227	· ·	(SOT618-21(D))	52
Fig. 8.	Gradation output waveform in single shot	Fig. 23.	Package outline notes HVQFN40	
	or continuous mode28		(SOT618-21(D))	53
Fig. 9.	Maximum ILED versus Rext31	Fig. 24.	Reflow soldering footprint part 1 for	
Fig. 10.	IO(target) versus IREFx value with Rext = 1		HVQFN40 (SOT618-21(D))	54
	kΩ31	Fig. 25.	Reflow soldering footprint part 2 for	
Fig. 11.	Brightness + Group Dimming signals35	· ·	HVQFN40 (SOT618-21(D))	55
Fig. 12.	System level connection36	Fig. 26.	Reflow soldering footprint part 3 for	
Fig. 13.	Data format37		HVQFN40 (SOT618-21(D))	56
Fig. 14.	Write access37	Fig. 27.	Temperature profiles for large and small	
Fig. 15.	Read access	-	components	59
Fig 16	Overlapped read and write access 38		•	

24-Channel SPI Serial Bus 63 mA/5.5 V Constant Current LED Driver

Contents

1	General description	2	7.6	Individual brightness control with group	
2	Features and benefits	3		dimming/blinking	34
3	Applications		8	Characteristics of the 4-wire SPI serial-	
4	Ordering information	5		bus interface	36
4.1	Ordering options		8.1	SPI-compatible 4-wire serial interface	
5	Block diagram	6		signals	36
6	Pinning information		8.2	Data format	37
6.1	Pinning		8.3	Write access sequence	37
6.2	Pin description		8.4	Read access sequence	37
7	Functional description	9	8.5	Overlapped read and write access	
7.1	Register address and data			sequence	38
7.2	Register definitions		9	Application design-in information	
7.2.1	MODE1 — Mode register 1		9.1	Thermal considerations	
7.2.2	MODE2 — Mode register 2		10	Limiting values	
7.2.3	LEDOUT0 to LEDOUT5, LED driver output		11	Thermal characteristics	
	state	16	12	Static characteristics	
7.2.4	GRPPWM, group duty cycle control		13	Dynamic characteristics	
7.2.5	GRPFREQ, group frequency		14	Test information	
7.2.6	PWM0 to PWM23, individual brightness		15	Package information: SOT618-21(D)	
	control	18	15.1	Package outline	
7.2.7	IREF0 to IREF23, LED output current value		15.2	Soldering	
	registers	19	16	Handling information	
7.2.8	Gradation control		17	Soldering of SMD packages	
7.2.8.1	RAMP_RATE_GRP0 to RAMP_RATE_		17.1	Introduction to soldering	
	GRP5, ramp rate control registers	21	17.2	Wave and reflow soldering	
7.2.8.2	STEP_TIME_GRP0 to STEP_TIME_GRP5,		17.3	Wave soldering	
	step time control registers	. 21	17.4	Reflow soldering	
7.2.8.3	HOLD_CNTL_GRP0 to HOLD_CNTL_		18	Acronyms	
	GRP5, hold ON and OFF control registers	. 21	19	Revision history	
7.2.8.4	IREF_GRP0 to IREF_GRP5, output gain			Legal information	
	control	22		9	
7.2.8.5	GRAD_MODE_SEL0 to GRAD_MODE_				
	SEL2, Gradation mode select registers	. 22			
7.2.8.6	GRAD_GRP_SEL0 to GRAD_GRP_SEL11,				
	Gradation group select registers	23			
7.2.8.7	GRAD_CNTL, Gradation control register				
7.2.8.8	Ramp control: Equation and calculation				
	example	. 26			
7.2.9	OFFSET: LEDn output delay offset register				
7.2.10	PWMALL: Brightness control for all LEDn	0			
1.2.10	outputs	. 29			
7.2.11	IREFALL register: Output current value for	= 0			
	all LED outputs	30			
7.2.12	LED driver constant current outputs				
7.2.12.1	Adjusting output current				
7.2.13	LED error detection				
7.2.13.1	Open-circuit detection principle				
7.2.13.2	Short-circuit detection principle				
7.2.14	Overtemperature protection				
7.3	Active LOW output enable input				
7.4	Power-on reset				
7.5	Hardware reset recovery				

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